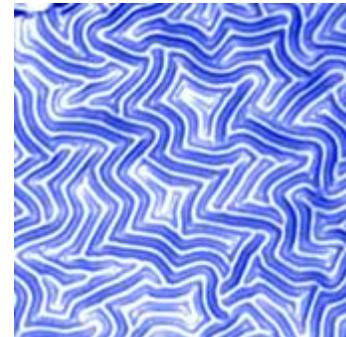
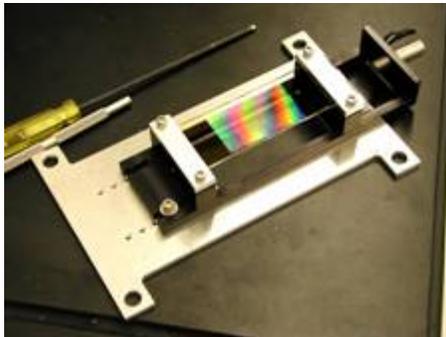
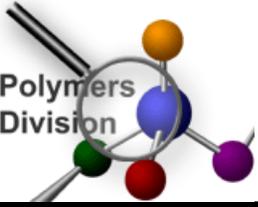


Surface wrinkling as a metrology tool

Christopher M. Stafford
Polymers Division
National Institute of Standards and Technology



ASME Applied Mechanics and Materials Conference
June 3-7, 2007
University of Texas at Austin



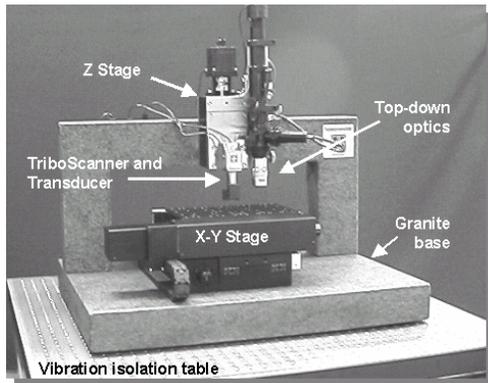
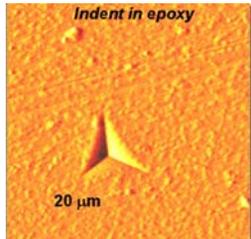
Motivation

Mechanical properties are critical in many applications

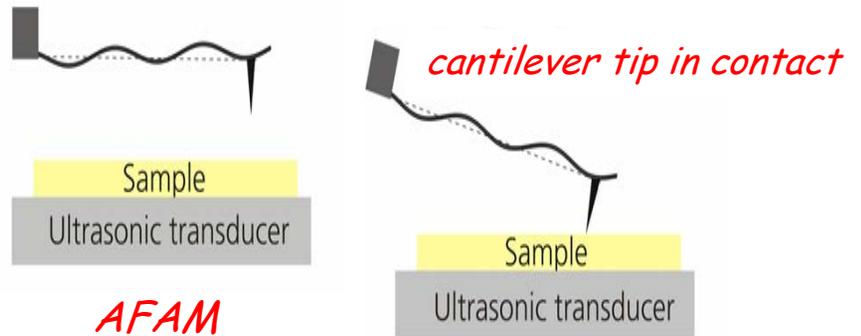
- predictive modeling of complex systems
- performance and reliability

Measuring mechanical properties of sub-micron (nano) films remains difficult

Indentation

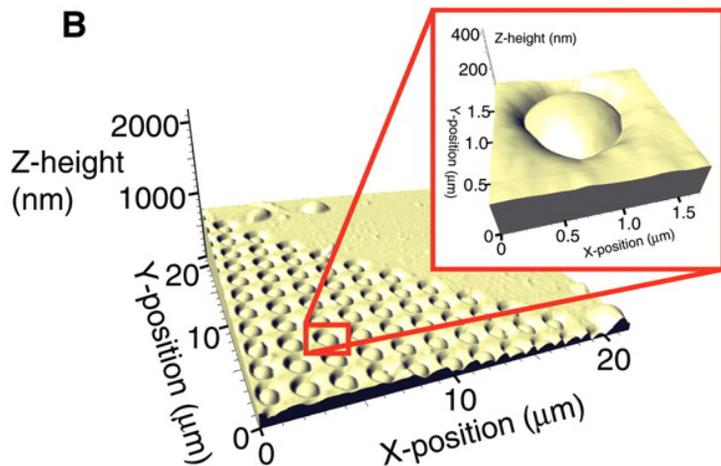


clamped-free AFM cantilever



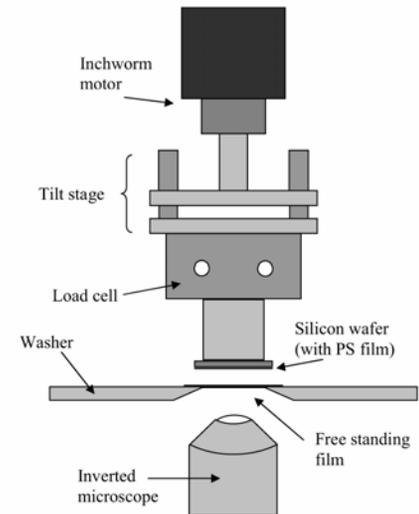
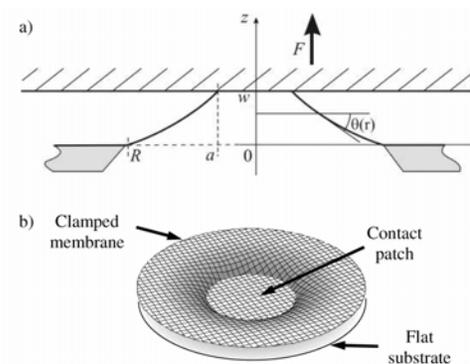
Rabe et al. *J Vac Sci Technol B* **15** 1506 (1997)
Hurley et al. *J Appl Phys* **94** 2347 (2003)

Nanobubbles



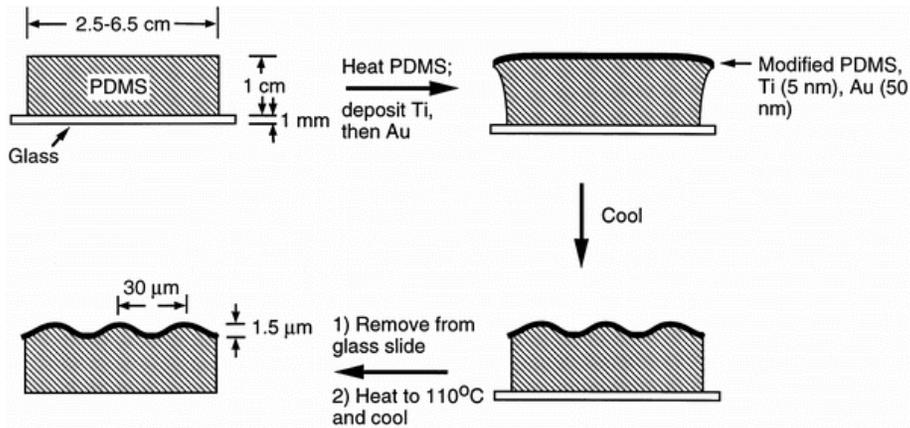
O'Connell and McKenna, *Science* **307**, 1760-1763 (2005).

Membrane punch

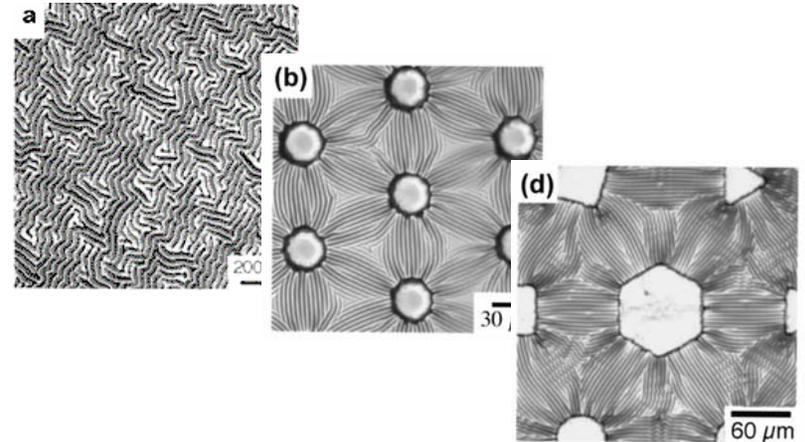


Raegan et al. *Eur. Phys. J. E* **19**, 453-459 (2006).

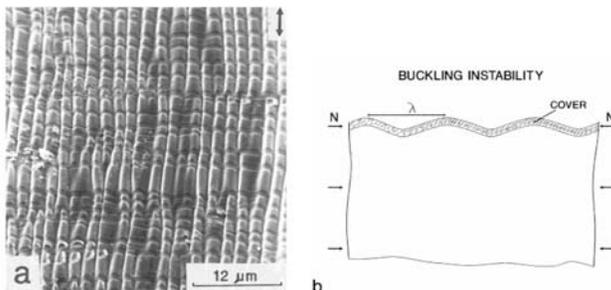
Surface wrinkling



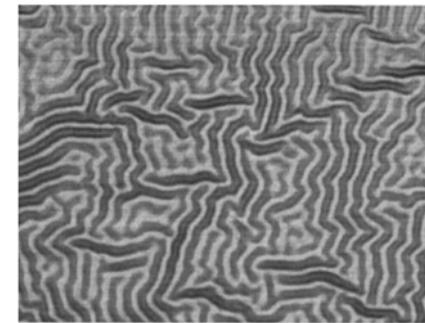
Bowden *et al. Nature* **393**, 146 (1998).



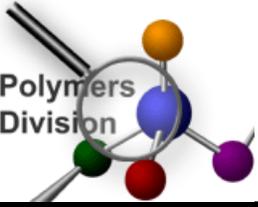
Bowden *et al. Appl. Phys. Lett.* **75**, 2557 (1999).



Volynskii *et al. J. Appl. Polym. Sci.* **72**, 1267 (1999).



Lacour, *et al. Appl. Phys. Lett.* **82**, 2404 (2003).



Surface wrinkling

Bending of an elastic layer on an elastic foundation:

$$\frac{E_f I}{(1 - \nu_f^2)} \frac{d^4 z}{dx^2} + F \frac{d^2 z}{dx^2} + kz = 0$$

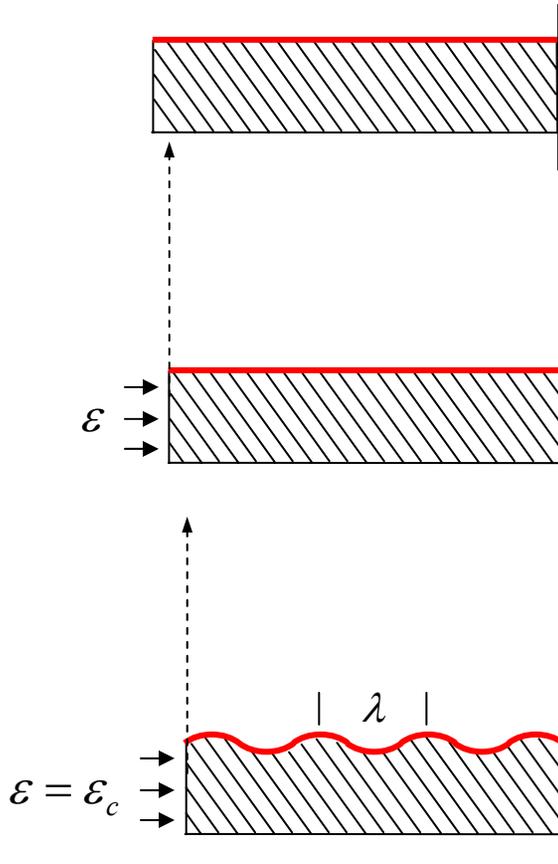
Assume sinusoidal deflection of the coating:

$$z = A \sin \frac{2\pi x}{\lambda}$$

Minimize the compressive force in the coating:

$$\frac{dF}{d\lambda} = 0$$

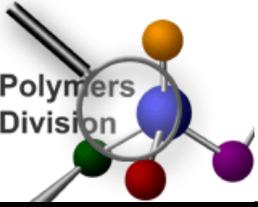
$$\lambda = 2\pi h_3 \sqrt{\frac{(1 - \nu_s^2) E_f}{3(1 - \nu_f^2) E_s}}$$



M.A. Biot, *J. Applied Mechanics* **4**, A1 (1937).

A.L. Volynskii *et al. J. Material Science* **25**, 547 (2000).

R. Huang, *J. Mechanics and Physics of Solids* **53**, 63 (2005).



Surface wrinkling

Governing Equations

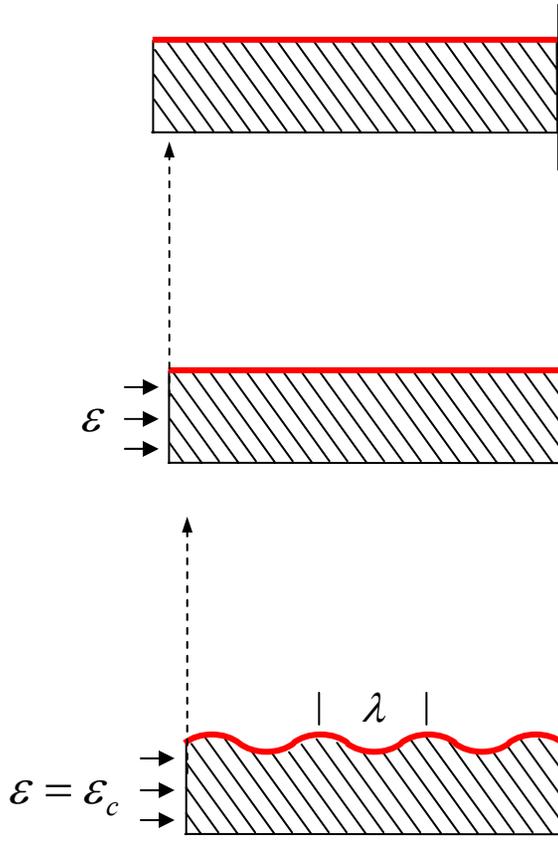
$$\varepsilon_c = -\frac{1}{4} \left(\frac{3\bar{E}_s}{\bar{E}_f} \right)^{2/3}$$

$$\sigma_c = \left(\frac{9\bar{E}_f \bar{E}_s^2}{64} \right)^{1/3}$$

$$\lambda_e = 2\pi h_f \left(\frac{\bar{E}_f}{3\bar{E}_s} \right)^{1/3}$$

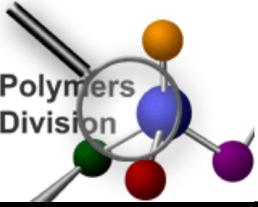
$$A_e = h_f \left(\frac{\varepsilon}{\varepsilon_c} - 1 \right)^{1/2}$$

where $\bar{E} = E / (1 - \nu^2)$



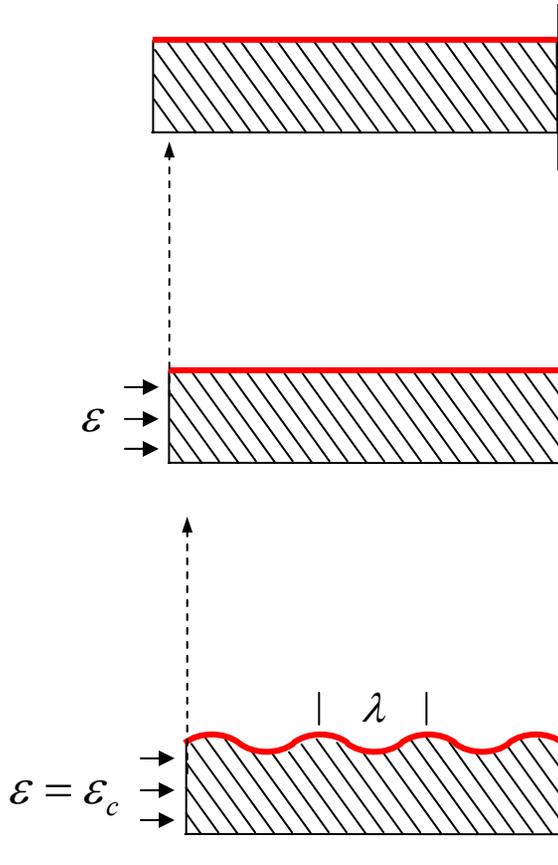
Assumptions:

- thick substrate ($h_s \gg h_f$)
- soft substrate ($E_s \ll E_f$)
- interface must be well-bonded.
- materials behave elastically



Surface wrinkling

Governing Equations



$$\varepsilon_c = -\frac{1}{4} \left(\frac{3\bar{E}_s}{\bar{E}_f} \right)^{2/3}$$

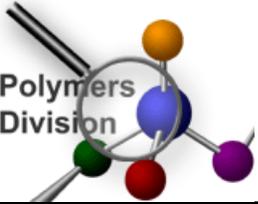
$$\sigma_c = \left(\frac{9\bar{E}_f \bar{E}_s^2}{64} \right)^{1/3}$$

$$\lambda_e = 2\pi h_f \left(\frac{\bar{E}_f}{3\bar{E}_s} \right)^{1/3}$$

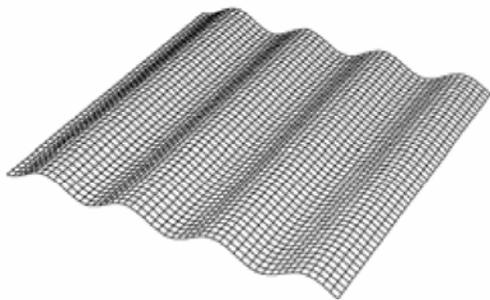
$$A_e = h_f \left(\frac{\varepsilon}{\varepsilon_c} - 1 \right)^{1/2}$$

where $\bar{E} = E / (1 - \nu^2)$

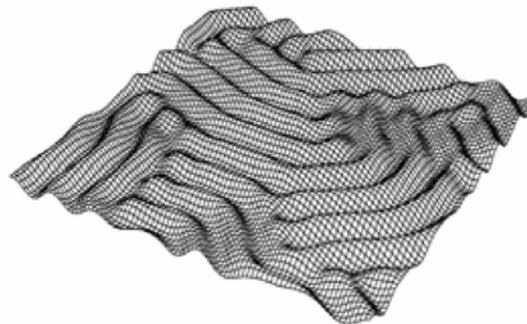
$$\bar{E}_f = 3\bar{E}_s \left(\frac{\lambda_e}{2\pi h_f} \right)^3$$



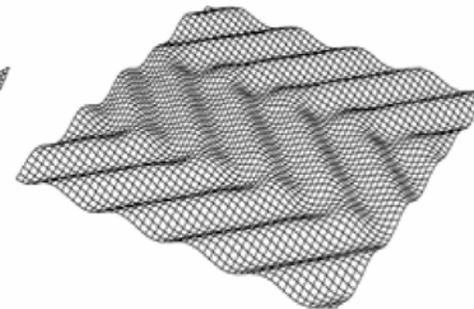
Surface wrinkling



Stripes

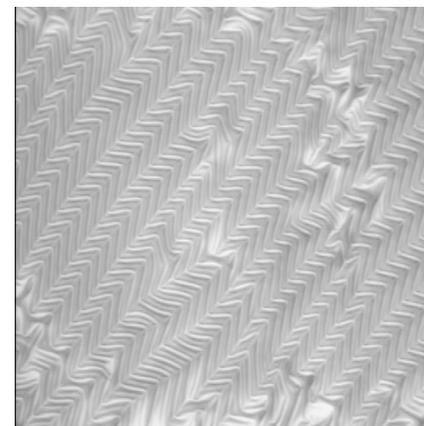
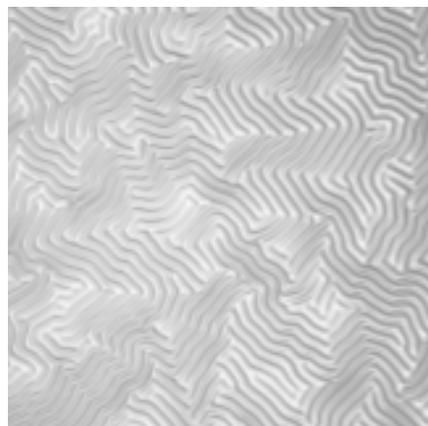
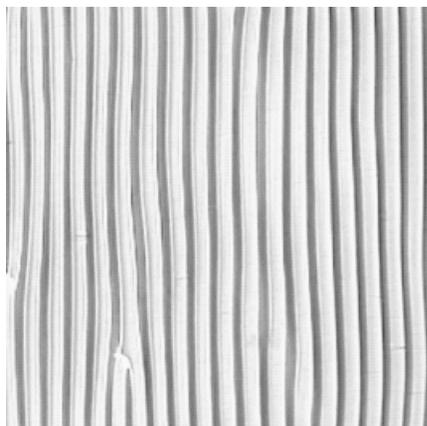


Labyrinths

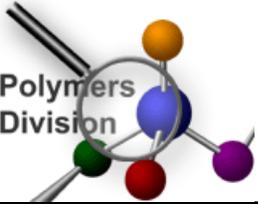


Herringbones

Huang, Hong, and Suo, *J. Mech. Phys. Solids* **53**, 2101 (2005).



Chung and Stafford, unpublished data.

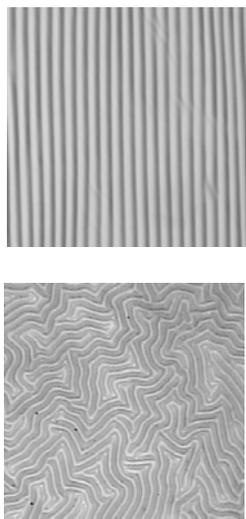


Metrology platform

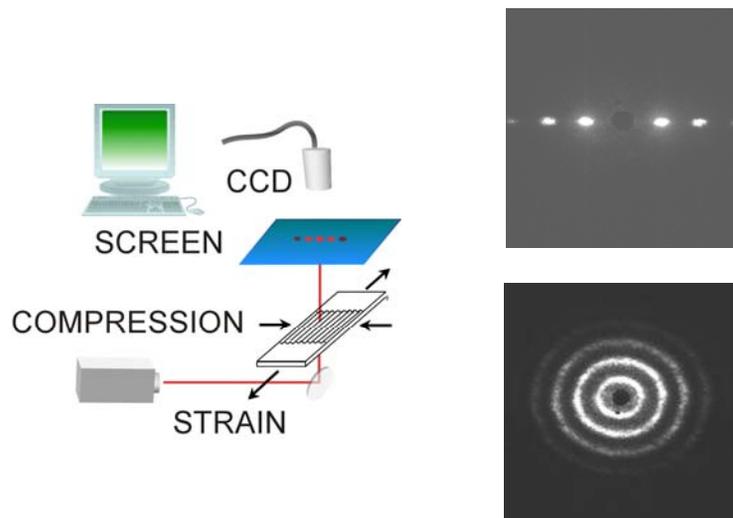
$$\bar{E}_f = 3\bar{E}_s \left(\frac{\lambda_e}{2\pi h_f} \right)^3$$

How to ascertain wavelength?

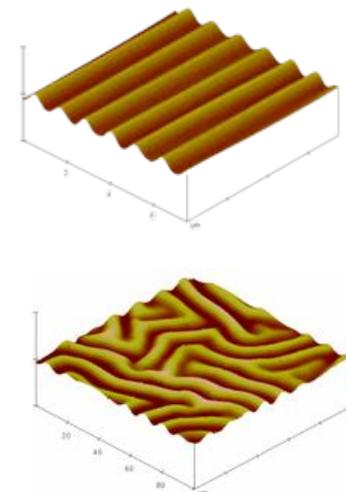
Optical microscopy

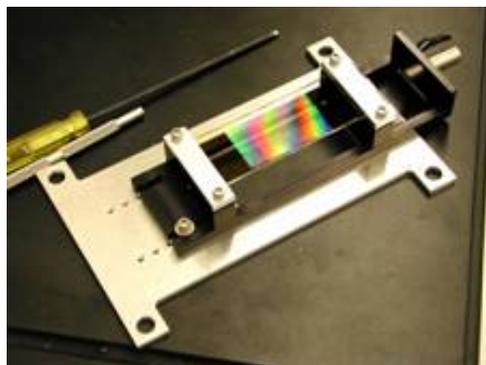


Small angle light scattering



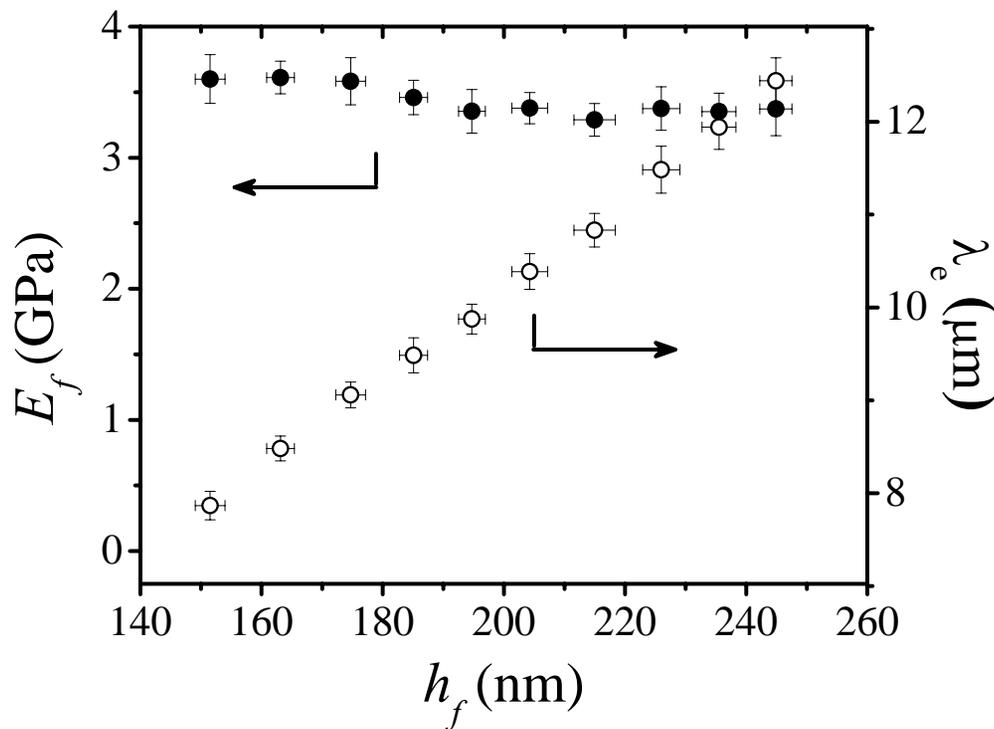
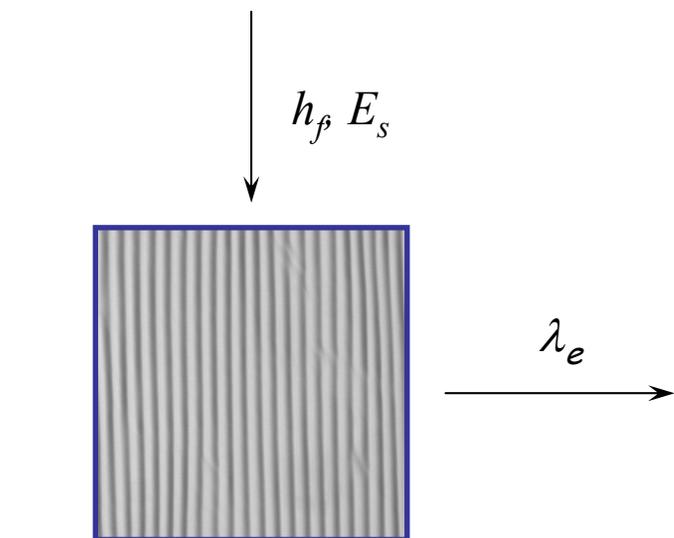
AFM

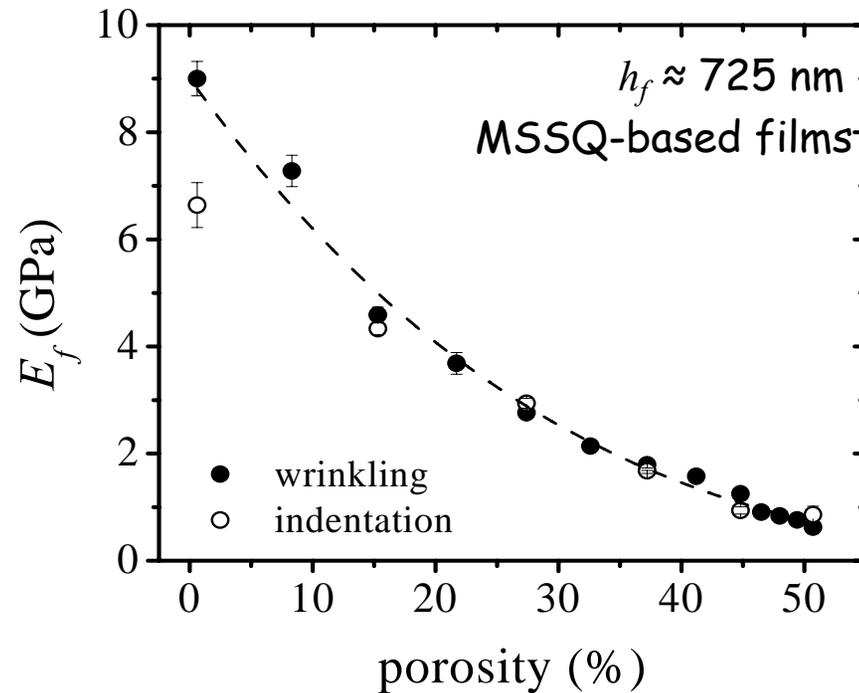
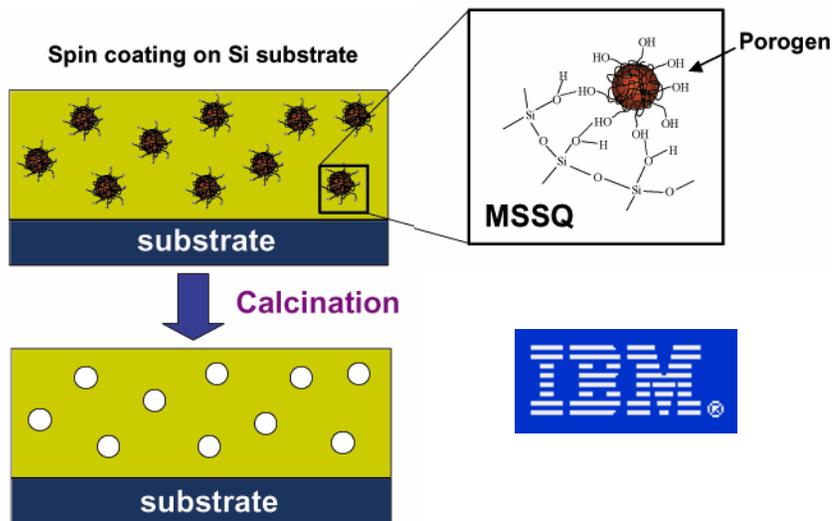




(mechanical compression)

$$\bar{E}_f = 3\bar{E}_s \left(\frac{\lambda_e}{2\pi h_f} \right)^3$$



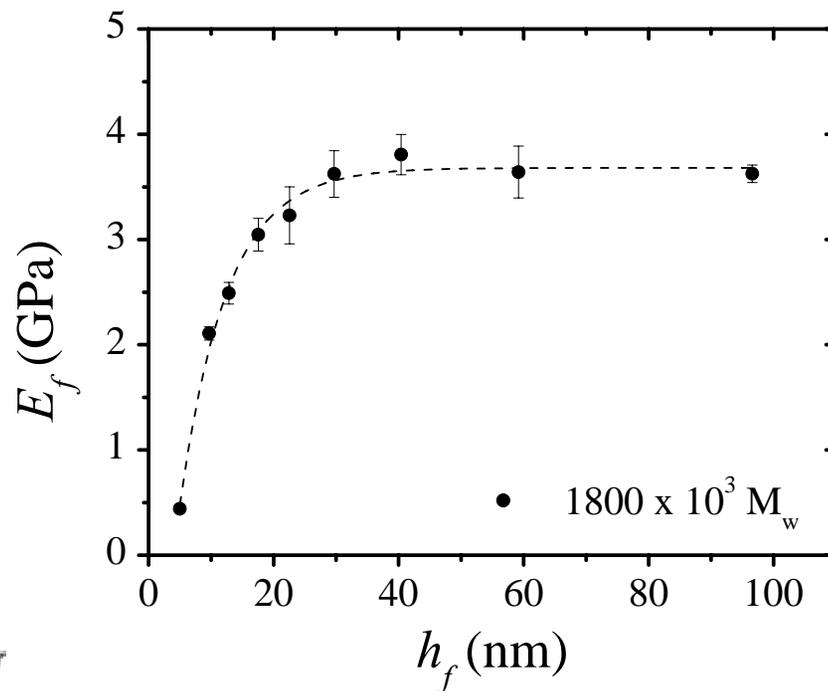
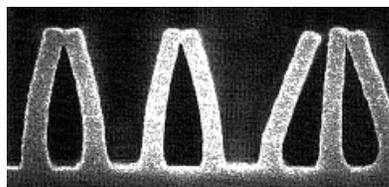
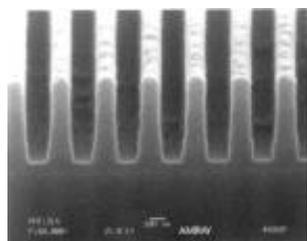


- Films cast on polished salt plates to facilitate film transfer.
- Wrinkling metrology could measure films down to 100 nm; indentation could not.
- Semiconductor industry needs $E_f > 4$ GPa to withstand CMP.



Ultrathin films

insufficient
mechanical strength



- Observe dramatic decrease in E_f below 30 nm
- Data can be explained by a surface layer ($h^*=2$ nm) with reduced modulus (almost rubbery).

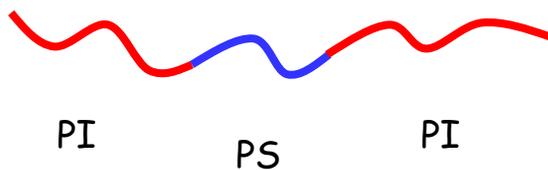
$$\lambda_e = 2\pi h_f \left(\frac{\bar{E}'_f}{3\bar{E}_s} \right)^{1/3}$$



Soft materials

NIST

National Institute of Standards and Technology
Technology Administration, U.S. Department of Commerce



Sample 1 $\phi_{PS} = 0.30$

Sample 2 $\phi_{PS} = 0.44$

Solution blended prior to spin-coating.

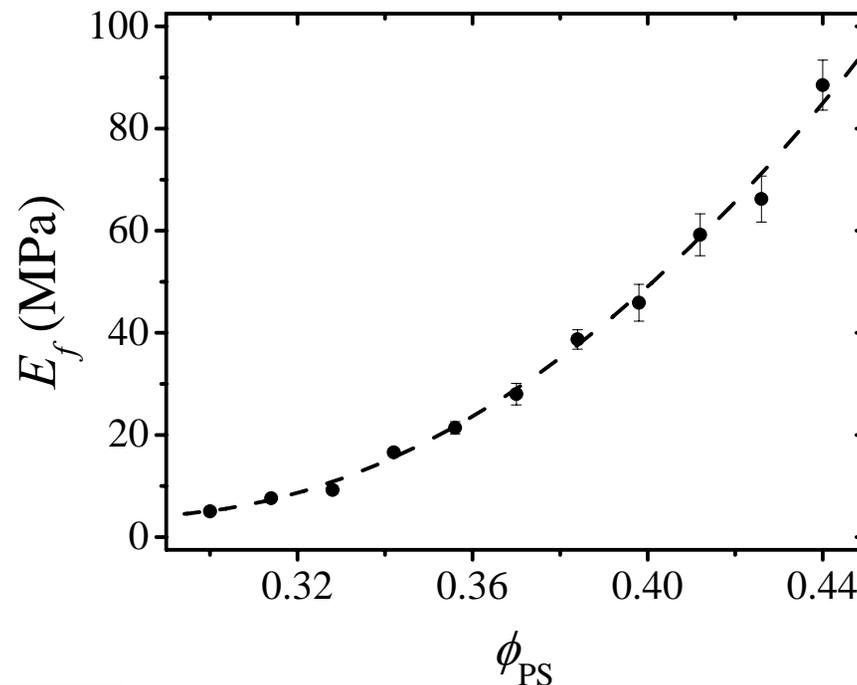
$$\lambda_e = 2\pi h_f \left(\frac{\bar{E}_f}{3\bar{E}_s} \right)^{1/3}$$

$$0.78 \mu\text{m} < \lambda_e < 2.0 \mu\text{m}$$

$$(h_f = 100 \text{nm})$$

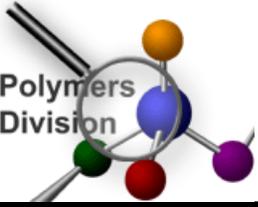
$$7.8 \mu\text{m} < \lambda_e < 20.0 \mu\text{m}$$

$$(h_f = 1 \mu\text{m})$$



$$\varepsilon_c = -\frac{1}{4} \left(\frac{3\bar{E}_s}{\bar{E}_f} \right)^{2/3}$$

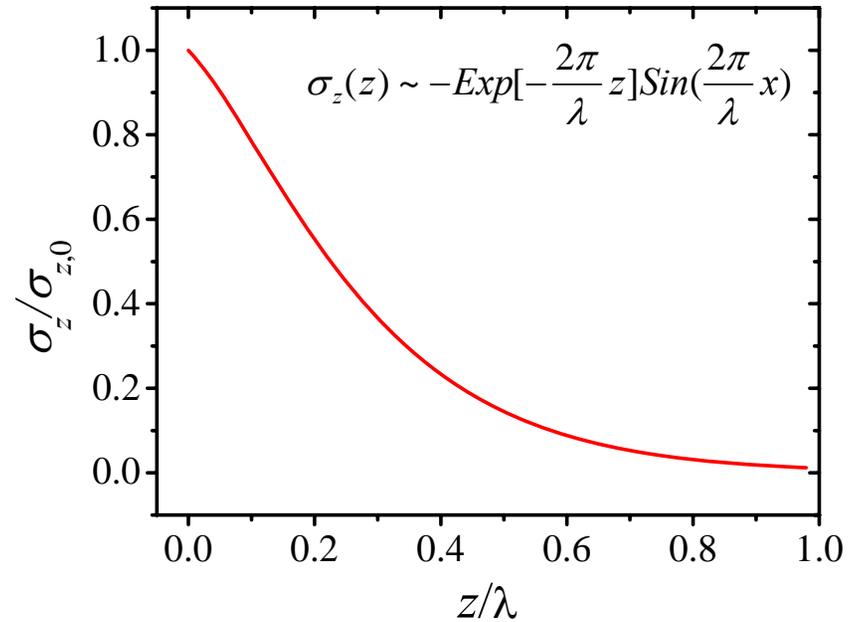
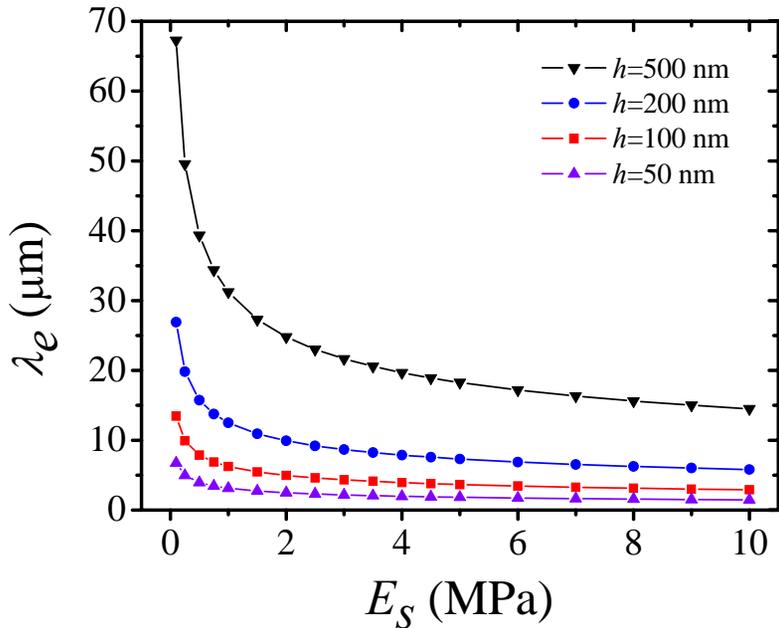
$$0.024 < \varepsilon_c < 0.179$$



Reverse metrology

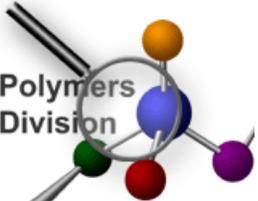
Employ a 'sensor' film of known modulus and thickness to report back the substrate modulus:

$$\bar{E}_f = 3\bar{E}_s \left(\frac{\lambda_e}{2\pi h_f} \right)^3 \longrightarrow \bar{E}_s = \frac{\bar{E}_f}{3} \left(\frac{\lambda_e}{2\pi h_f} \right)^{-3}$$



- Approach is most sensitive for $E_s < 2$ MPa
- Thickness of sensor film is critical for measurement sensitivity

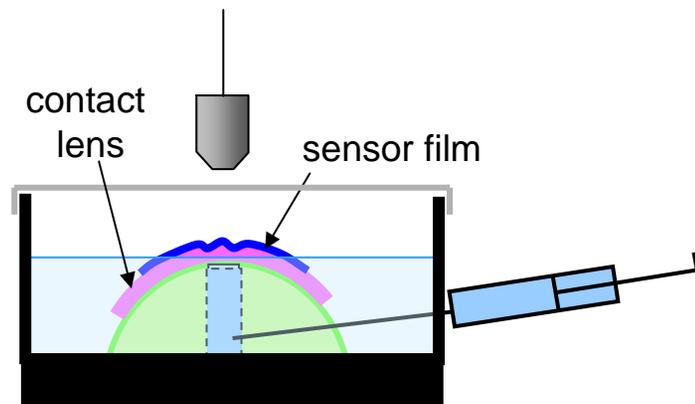
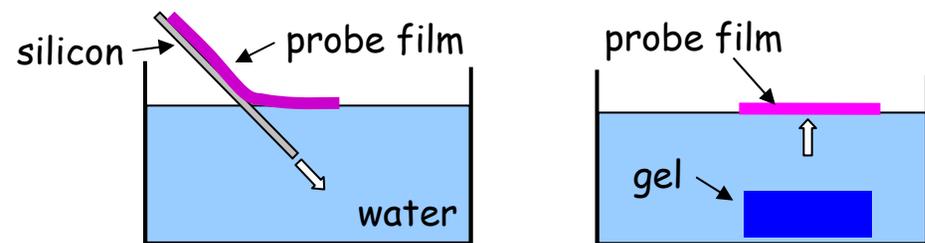
- Stress decays into the substrate on the order of a wavelength (λ_e)



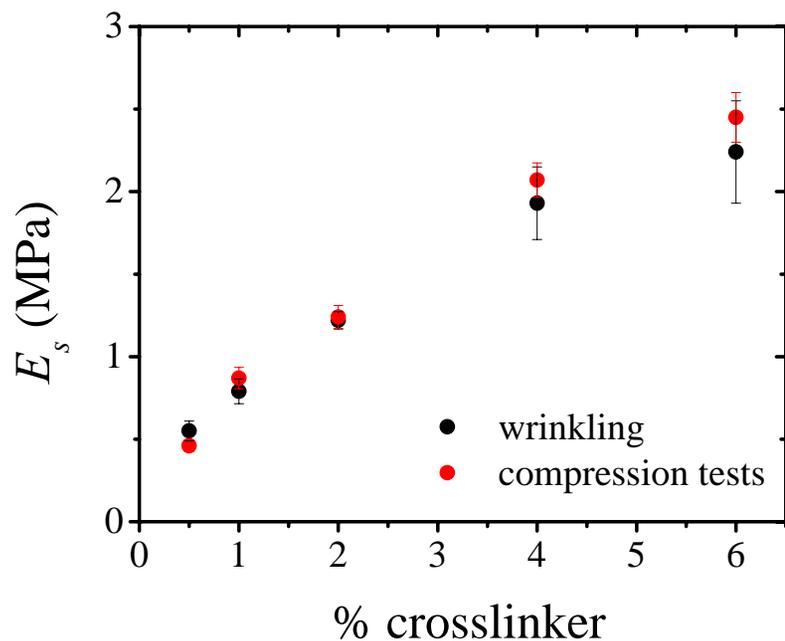
Reverse metrology

NIST

National Institute of Standards and Technology
Technology Administration, U.S. Department of Commerce



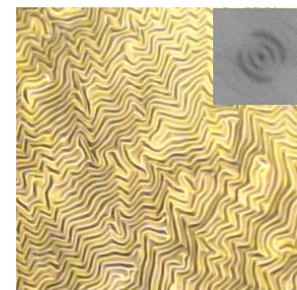
PMMA/contact lens



NCMC Focus Project

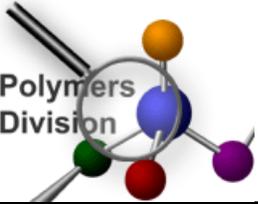
Surevue Etafilcon A

$$E_s = 0.41 \pm 0.02 \text{ MPa}$$



Vistakon Division

of Johnson & Johnson Vision Care, Inc.

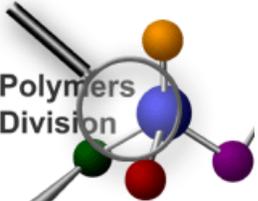


New directions

NIST

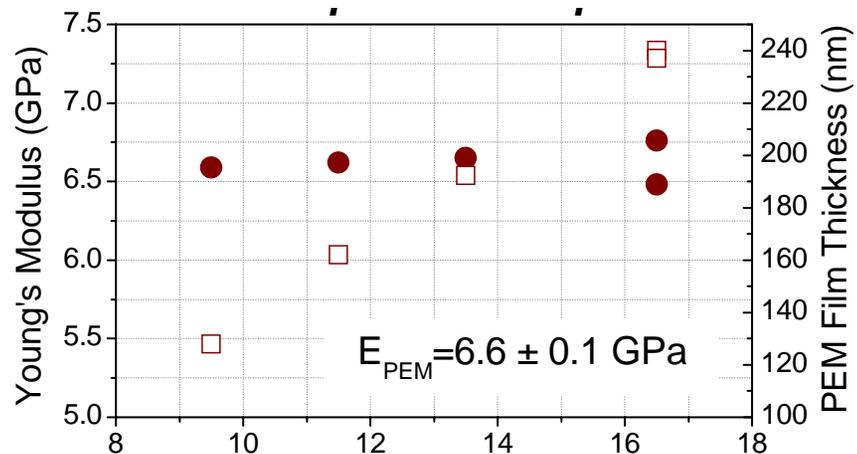
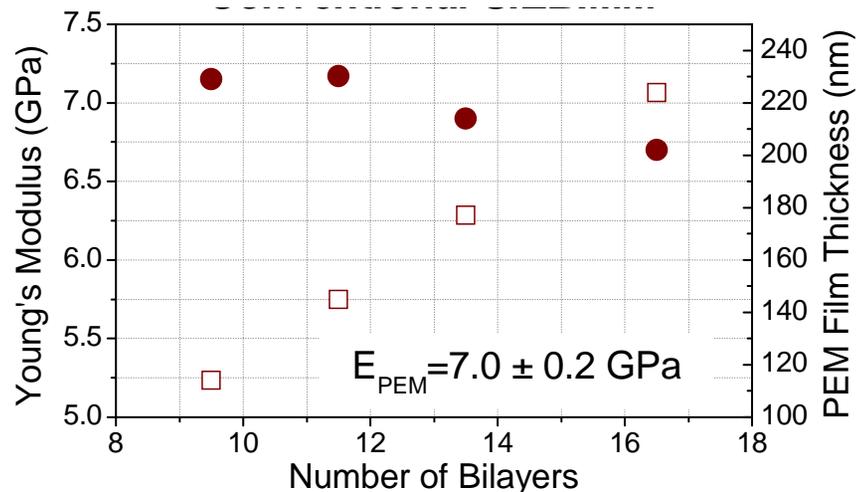
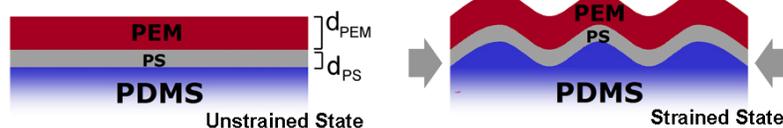
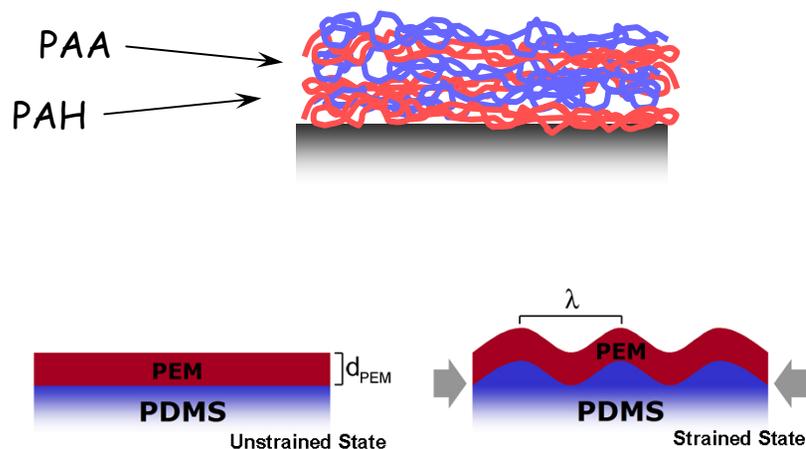
National Institute of Standards and Technology
Technology Administration, U.S. Department of Commerce

- Application to new materials
 - LbL assemblies
 - polymer brushes
- Extend metrology to new measurements
 - critical strain
 - viscoelastic wrinkling



Wrinkling of PEMs

LbL assembly of polyelectrolytes directly on PDMS

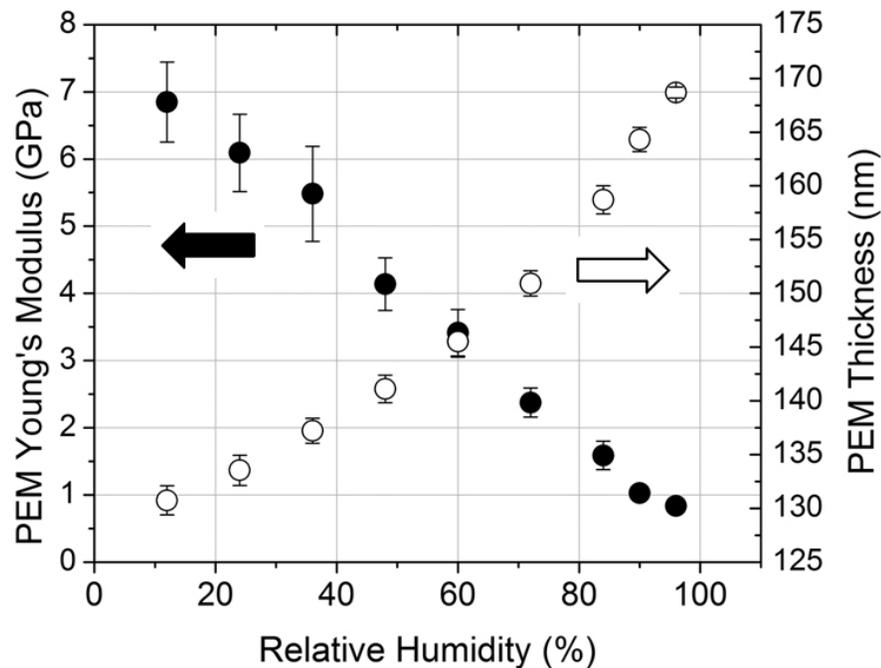
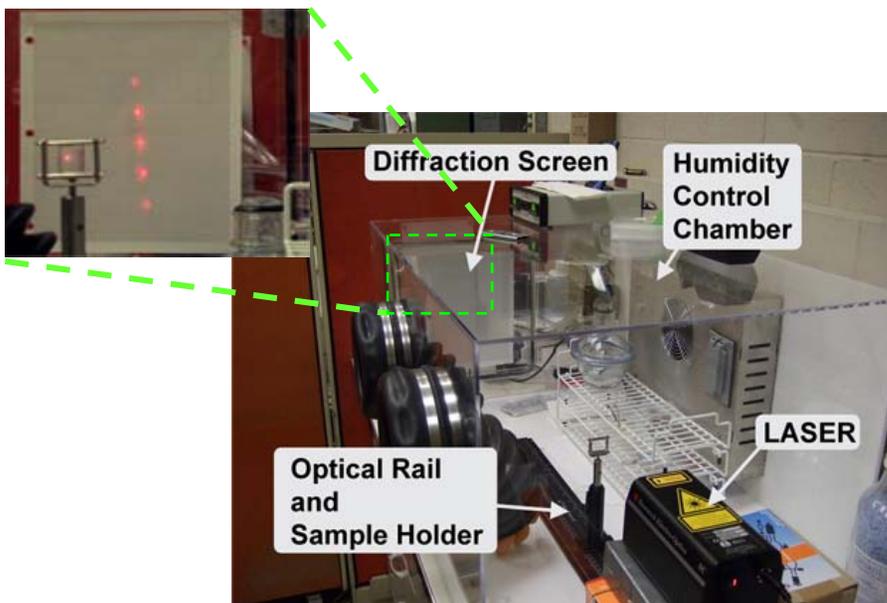
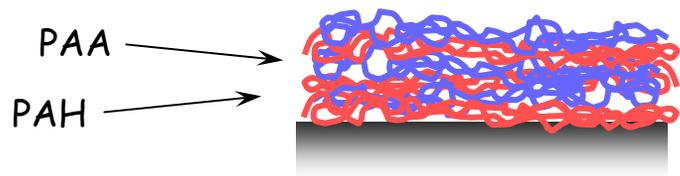


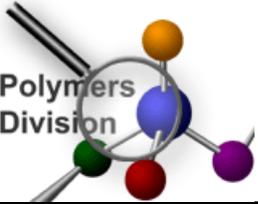
Nolte et al. *Macromolecules* **38**, 5367 (2005).
Nolte et al. *Macromolecules* **39**, 4841 (2006).



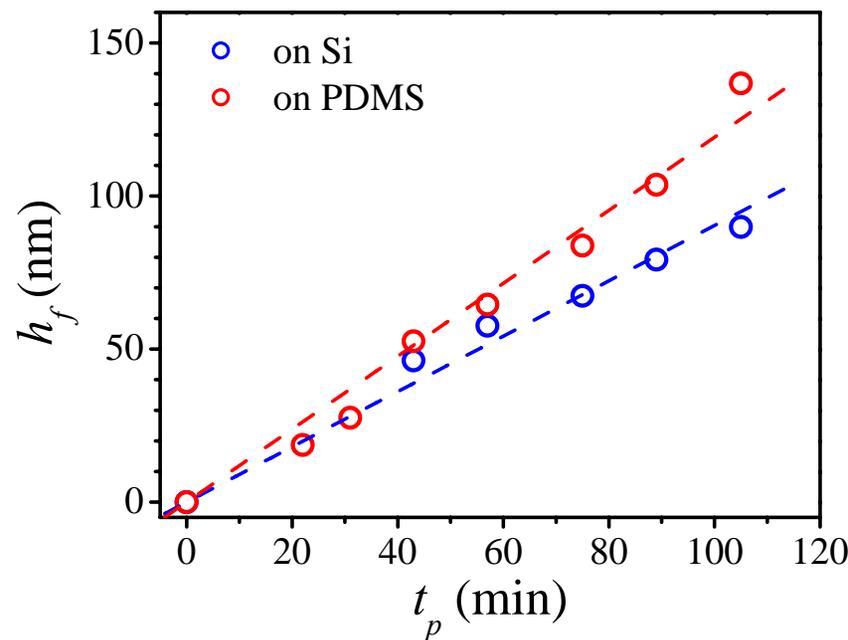
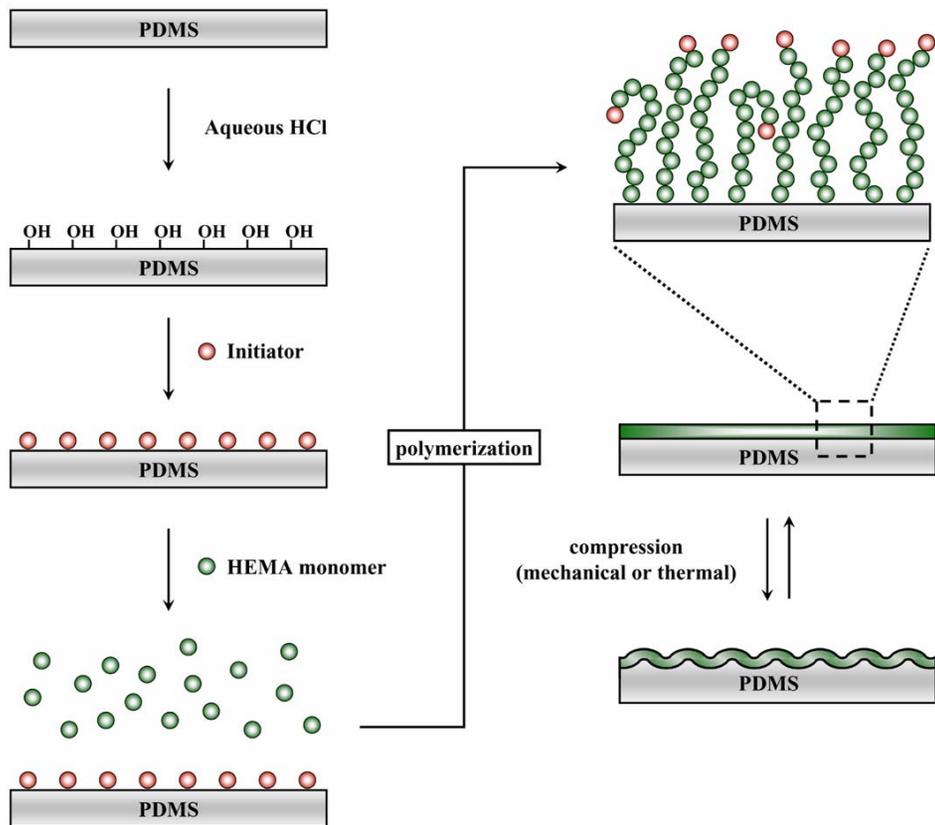
Wrinkling of PEMs

LbL assembly of polyelectrolytes directly on PDMS



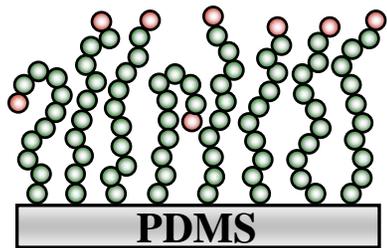


Wrinkling of brushes



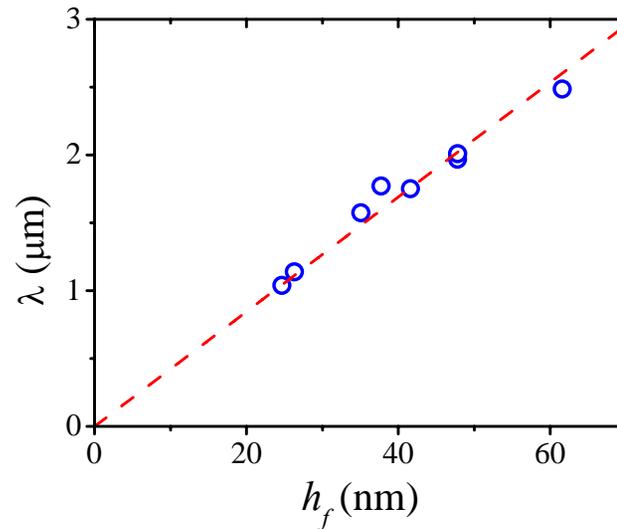
- thickness grows linearly with reaction time (t_p)
- comparable thickness on PDMS as silicon.

Thermal wrinkling

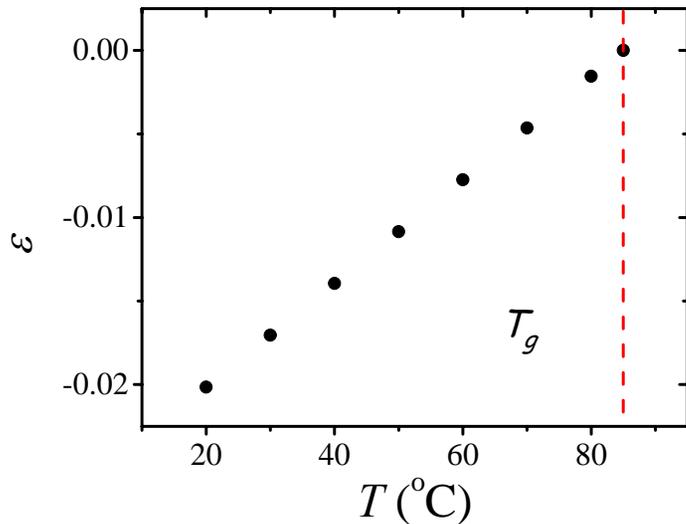


$$\lambda_e = 2\pi h_f \left(\frac{\bar{E}_f}{3\bar{E}_s} \right)^{1/3}$$

Wrinkling wavelength on PDMS:

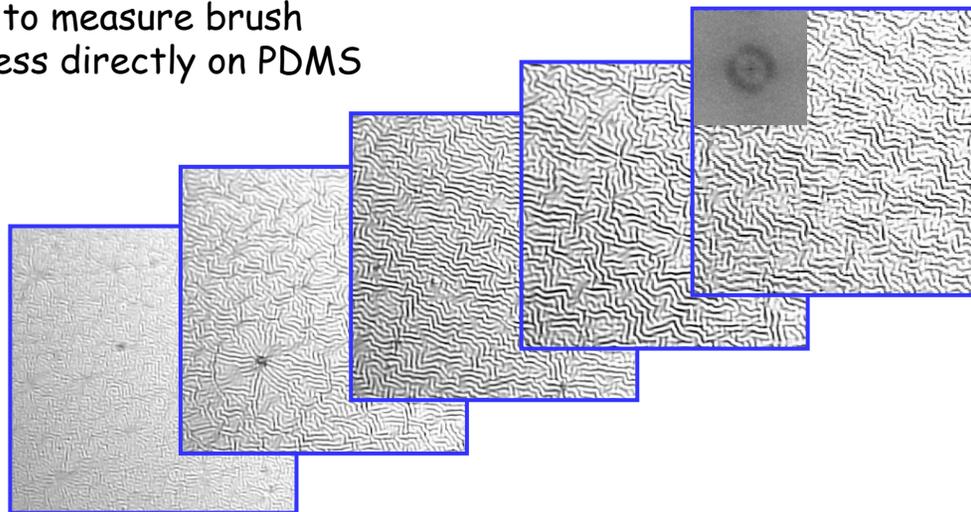


- Heat film/substrate above T_g for pHEMA ($\sim 85^\circ\text{C}$)
- Upon cooling, compressive stress/strain is generated



$\epsilon_c = -0.008$ for pHEMA on PDMS

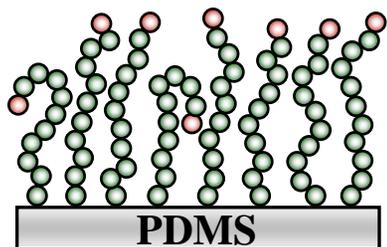
- need to measure brush thickness directly on PDMS



H. Huang et al. *in preparation* (2007).



Wrinkling of brushes

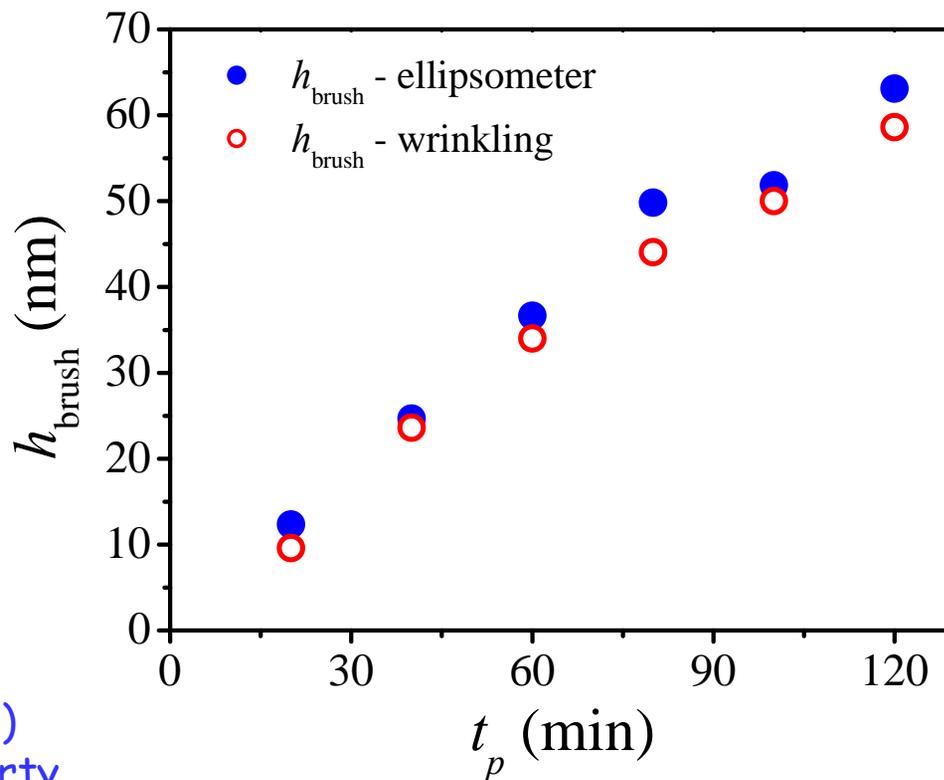


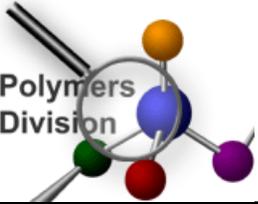
$$h_f = \frac{\lambda_e}{2\pi} \left(\frac{\bar{E}_f}{3\bar{E}_s} \right)^{-1/3}$$

Measure brush thickness via wrinkling!

- assume bulk modulus
- wavelength \rightarrow thickness

A macroscopic measurement (wavelength)
can provide accurate measure of a property
at the nanometer scale (thickness)



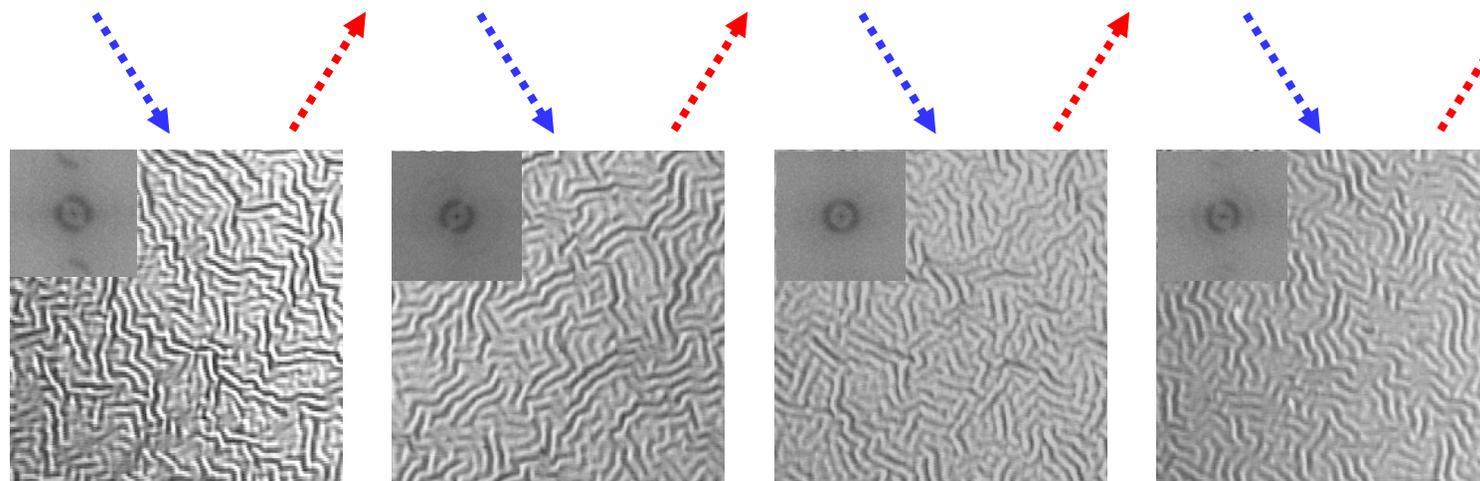
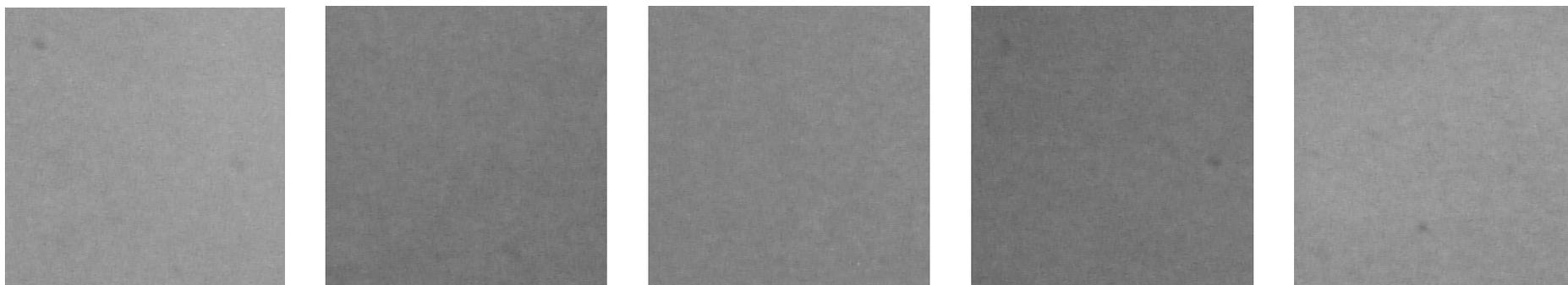


Reversibility in wrinkled brushes

NIST

National Institute of Standards and Technology
Technology Administration, U.S. Department of Commerce

-➔ Heating/cooling cycle
-➔ Rinse with solvent (DMF/methanol)

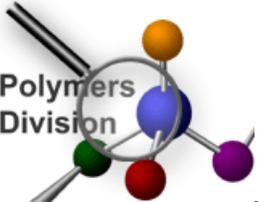


$\lambda = 1.78 \pm 0.19$ mm

$\lambda = 1.92 \pm 0.10$ mm

$\lambda = 1.89 \pm 0.14$ mm

$\lambda = 1.88 \pm 0.06$ mm



Critical strain

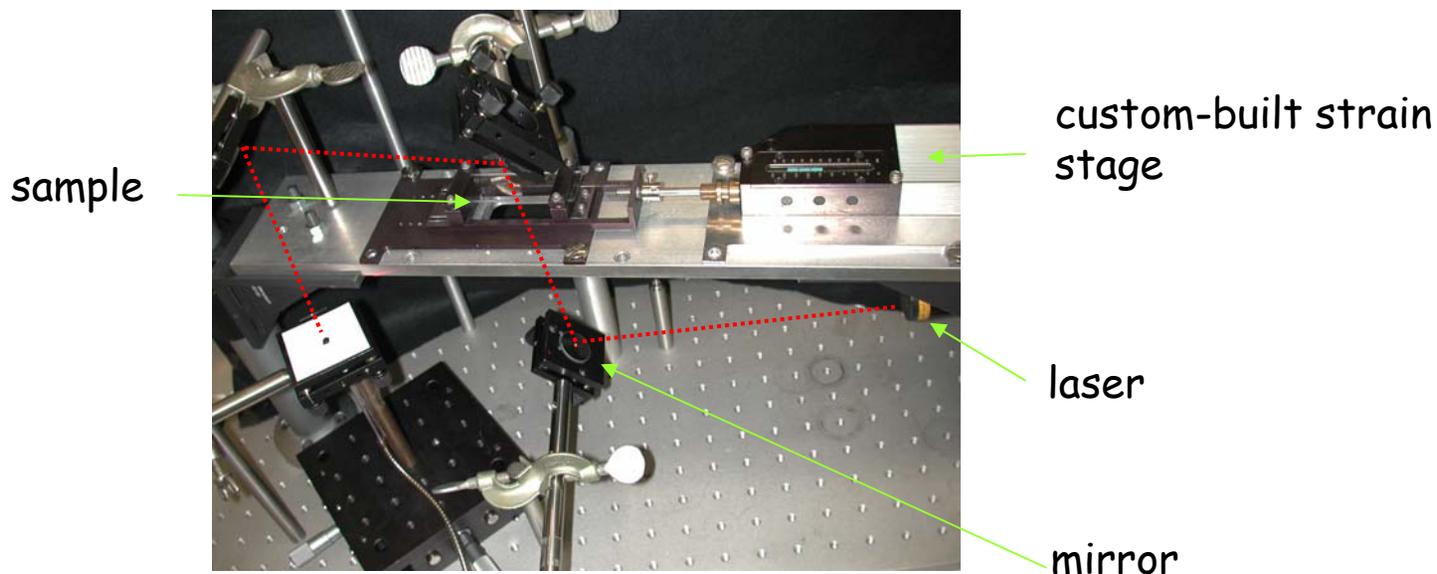
$$\lambda_e = 2\pi h_f \left(\frac{\bar{E}_f}{3\bar{E}_s} \right)^{1/3}$$

- thickness dependence (**linear**)
- modulus ratio to the 1/3

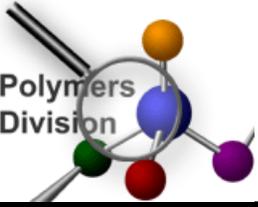
$$\varepsilon_c = -\frac{1}{4} \left(\frac{3\bar{E}_s}{\bar{E}_f} \right)^{2/3}$$

- **no** thickness dependence
- modulus ratio to the 2/3

o One way to detect critical strain (ε_c) is through OM or LS...



Measure the scattered intensity as a function of compressive strain.



Critical strain - LS

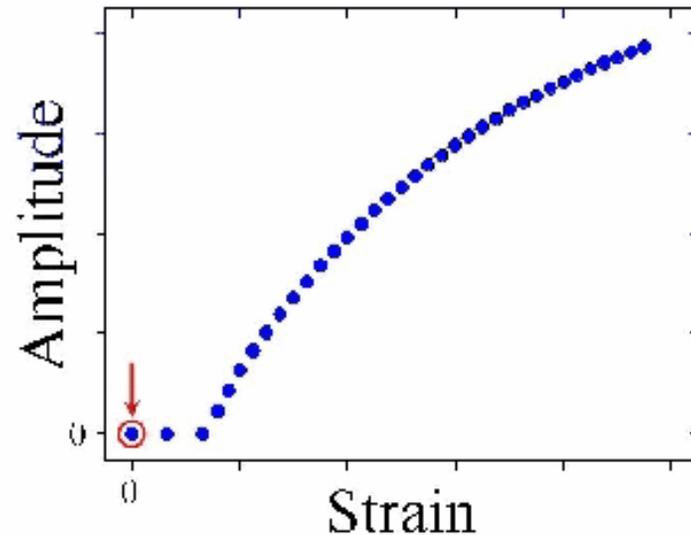
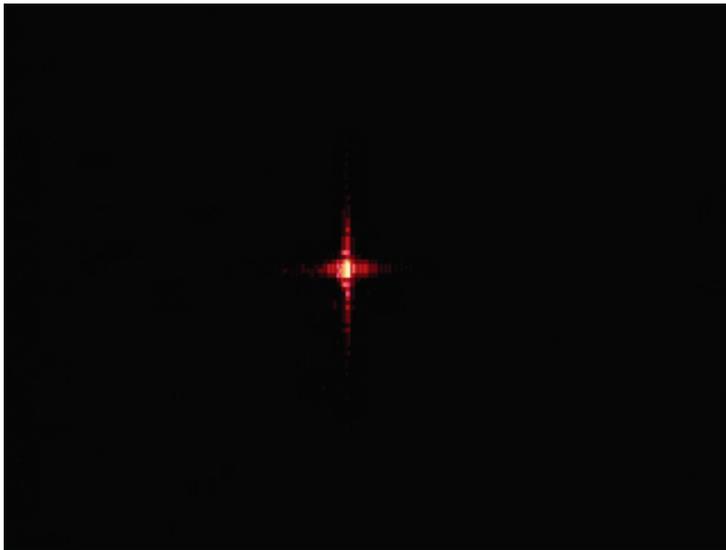
$$\lambda_e = 2\pi h_f \left(\frac{\bar{E}_f}{3\bar{E}_s} \right)^{1/3}$$

$$\varepsilon_c = -\frac{1}{4} \left(\frac{3\bar{E}_s}{\bar{E}_f} \right)^{2/3}$$

- thickness dependence (**linear**)
- modulus ratio to the 1/3

- **no** thickness dependence
- modulus ratio to the 2/3

○ One way to detect critical strain (ε_c) is through OM or LS....

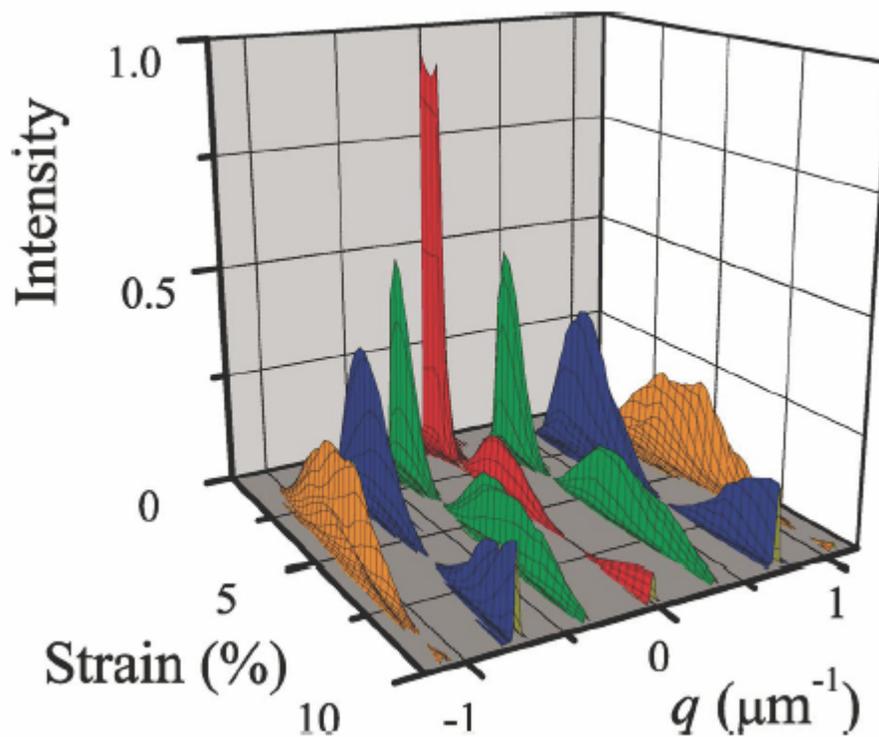




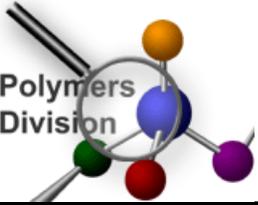
Critical strain

NIST

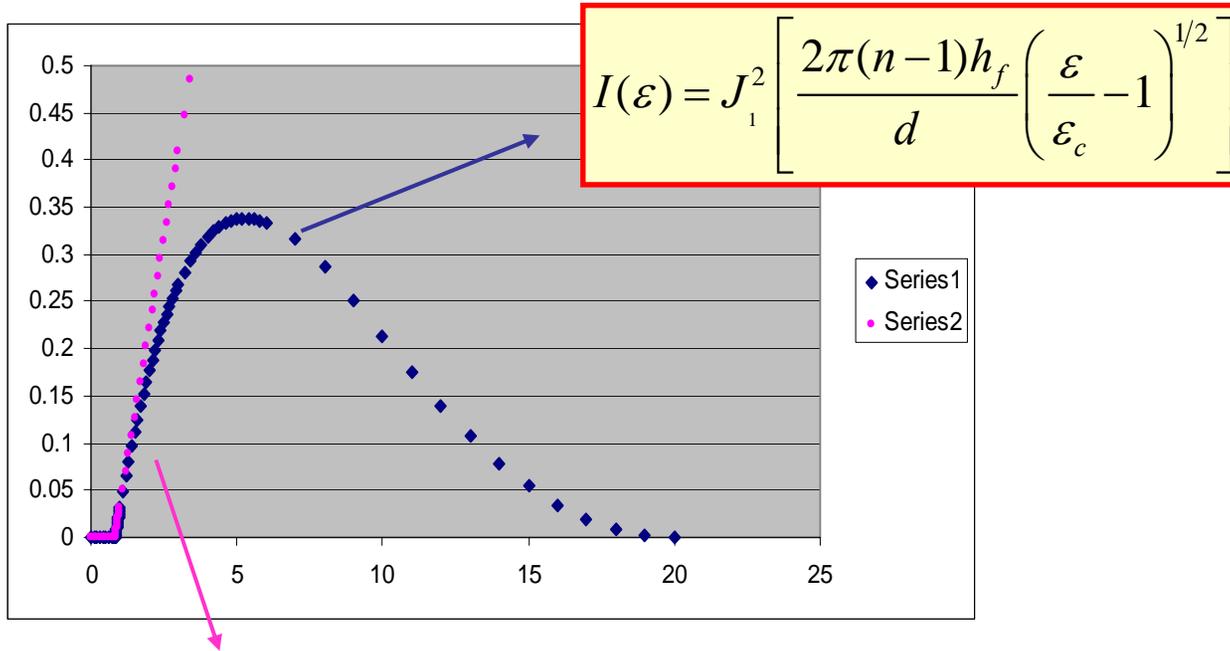
National Institute of Standards and Technology
Technology Administration, U.S. Department of Commerce



$$I[q] \approx \sum_{p=-\infty}^{\infty} J_p^2\left(\frac{m}{2}\right) \text{sinc}^2\left[\frac{W}{\pi}\left(q - \frac{2p\pi}{d}\right)\right],$$



Critical strain

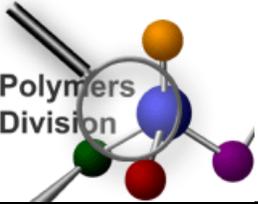


$$\left\{ \begin{array}{l} \lambda = 2\pi h_f \left(\frac{\bar{E}_f}{3\bar{E}_s} \right)^{1/3} \\ \varepsilon_c = -\frac{1}{4} \left(\frac{3\bar{E}_s}{\bar{E}_f} \right)^{2/3} \\ A = h_f \left(\frac{\varepsilon}{\varepsilon_c} - 1 \right)^{1/2} \end{array} \right.$$

$$I(\varepsilon) = \left(\frac{\pi(n-1)h_f}{d} \right)^2 \left(\frac{\varepsilon}{\varepsilon_c} - 1 \right)$$

For small argument, $0 < x \ll \sqrt{2}$, $J_1(x) \rightarrow x/2$

The intensity of the first order diffracted beam follows the linear dependence on the applied strain when $\varepsilon < 1.25\varepsilon_c$.



Critical strain

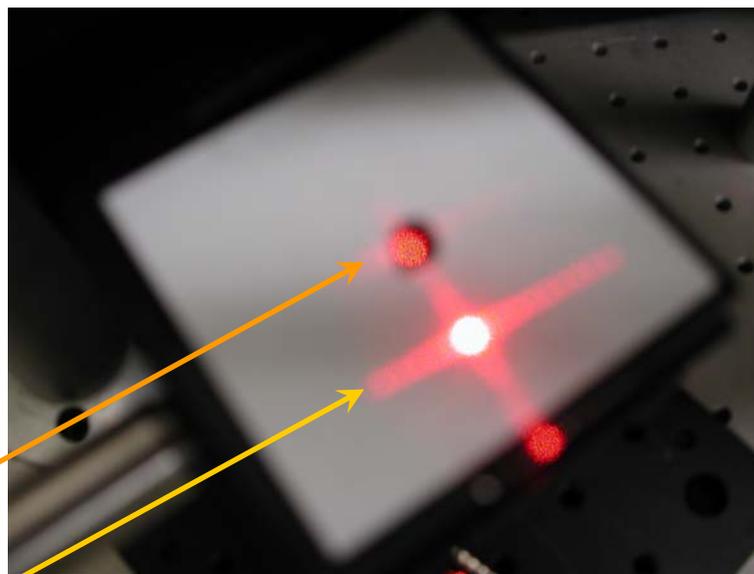
$$\lambda_e = 2\pi h_f \left(\frac{\bar{E}_f}{3\bar{E}_s} \right)^{1/3}$$

- thickness dependence (**linear**)
- modulus ratio to the 1/3

$$\varepsilon_c = -\frac{1}{4} \left(\frac{3\bar{E}_s}{\bar{E}_f} \right)^{2/3}$$

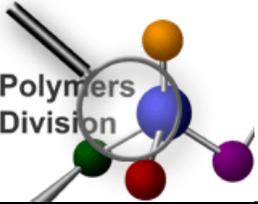
- **no** thickness dependence
- modulus ratio to the 2/3

- One way to detect critical strain (ε_c) is through OM or LS...

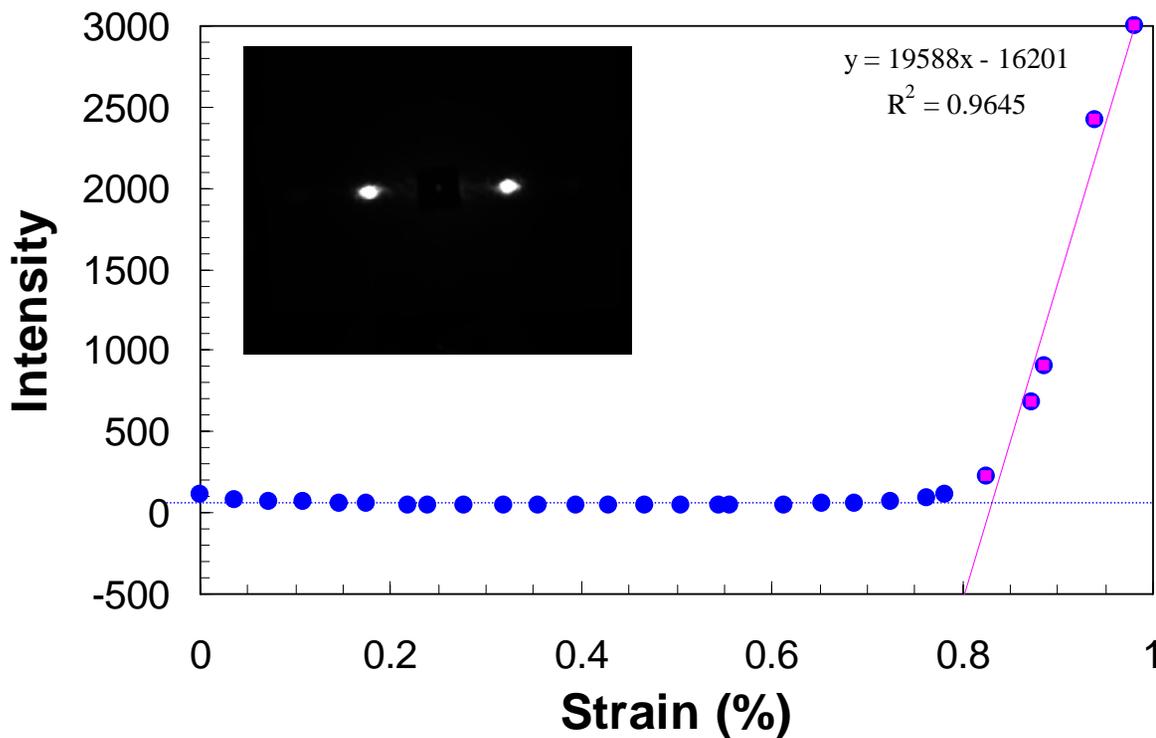


wavenumber
(~wavelength)

1st order diffraction spot



Critical strain - PS/PDMS



$h \sim 197 \text{ nm}$

$\lambda \sim 9.4 \mu\text{m}$ (measured)

$$\lambda = 2\pi h_f \left(\frac{\overline{E}_f}{3\overline{E}_s} \right)^{1/3}$$

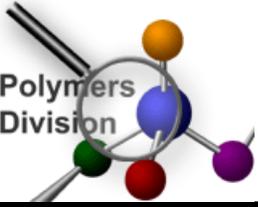
$E_f \sim 3.1 \text{ GPa}$ (calculated)

$$\varepsilon_c = -\frac{1}{4} \left(\frac{3\overline{E}_s}{\overline{E}_f} \right)^{2/3}$$

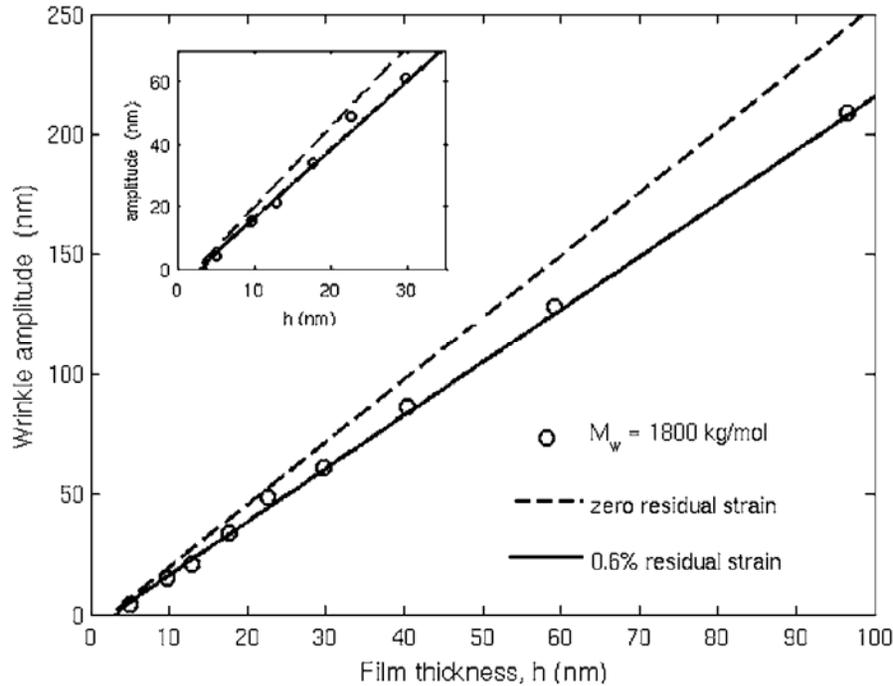
$\varepsilon_c \sim 0.44\%$ (calculated)

$\varepsilon_c \sim 0.83\%$ (measured)

Residual strain (or stress) ?



Critical strain



$$A = h_f \sqrt{\frac{\varepsilon + \eta}{\varepsilon_c + \eta} - 1}$$

η is a residual surface strain

$$h \sim 197 \text{ nm}$$

$$\lambda \sim 9.4 \mu\text{m} \text{ (measured)}$$

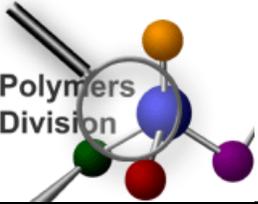
$$\lambda = 2\pi h_f \left(\frac{\overline{E}_f}{3\overline{E}_s} \right)^{1/3}$$

$$E_f \sim 3.1 \text{ GPa} \text{ (calculated)}$$

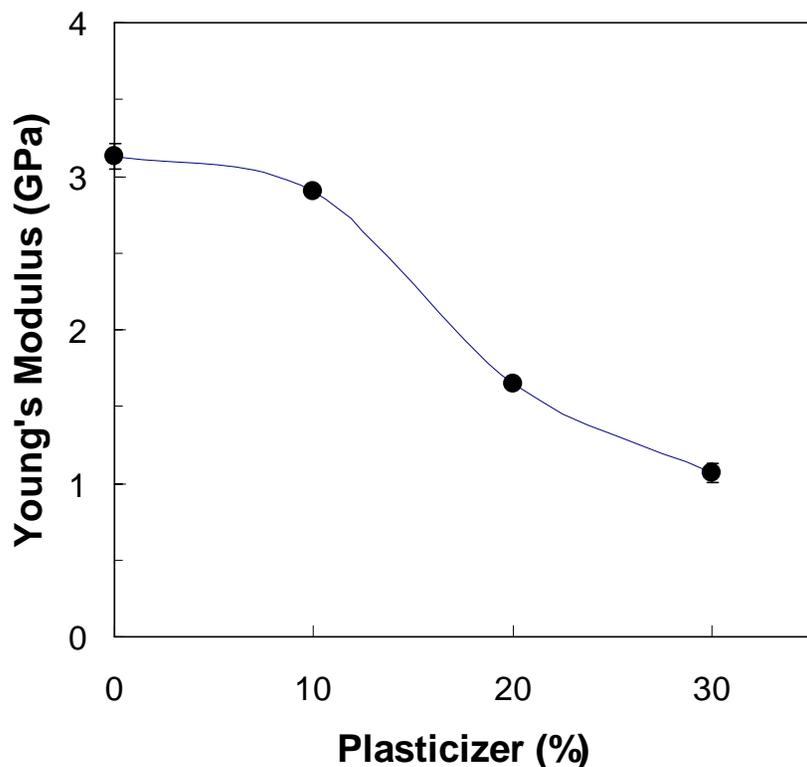
$$\varepsilon_c = -\frac{1}{4} \left(\frac{3\overline{E}_s}{\overline{E}_f} \right)^{2/3}$$

$$\varepsilon_c \sim 0.44\% \text{ (calculated)}$$

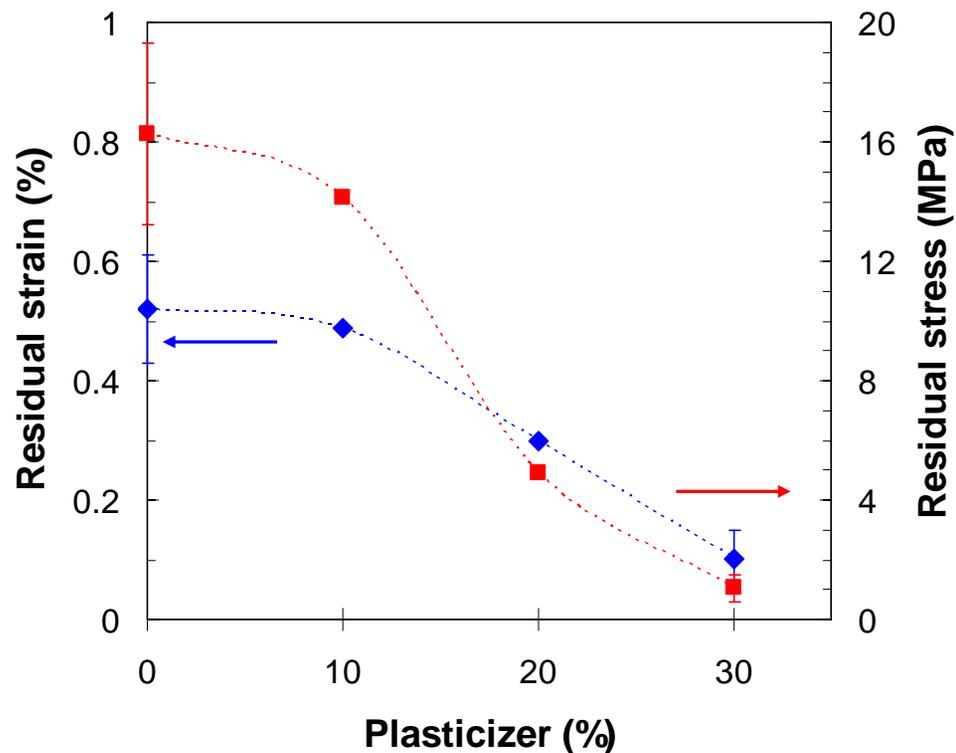
$$\varepsilon_c \sim 0.83\% \text{ (measured)}$$



Critical strain - pPS/PDMS



* Moduli were determined using the wrinkling wavelength

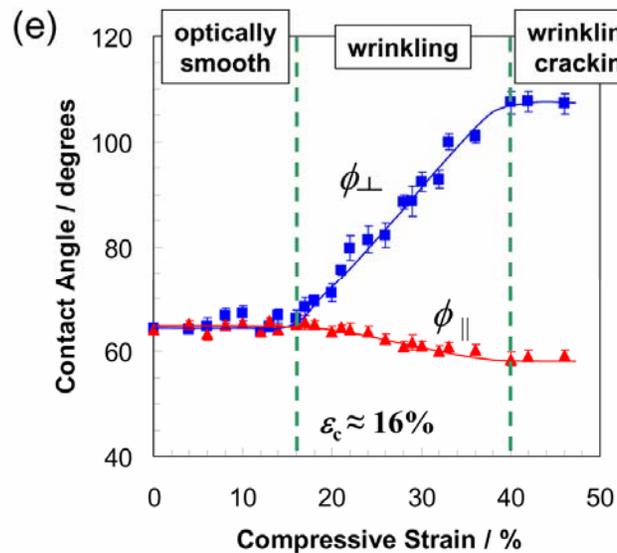
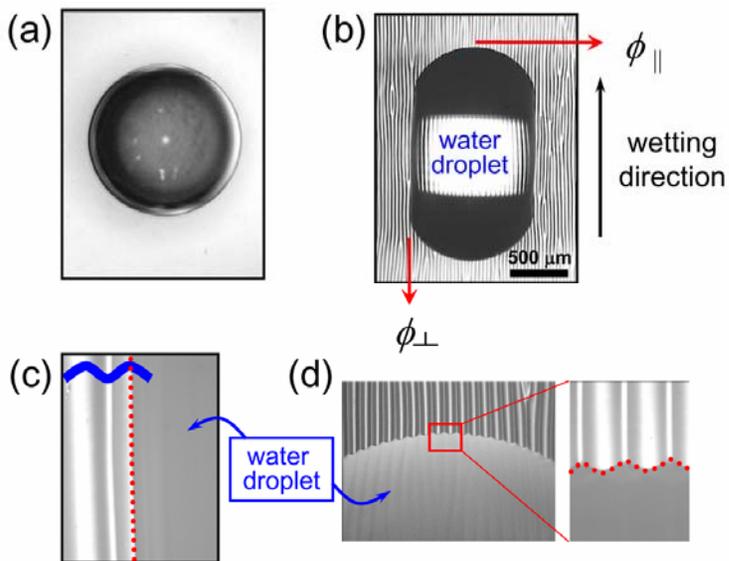


** Residual strains were determined by taking the difference between the measured and calculated critical strains.

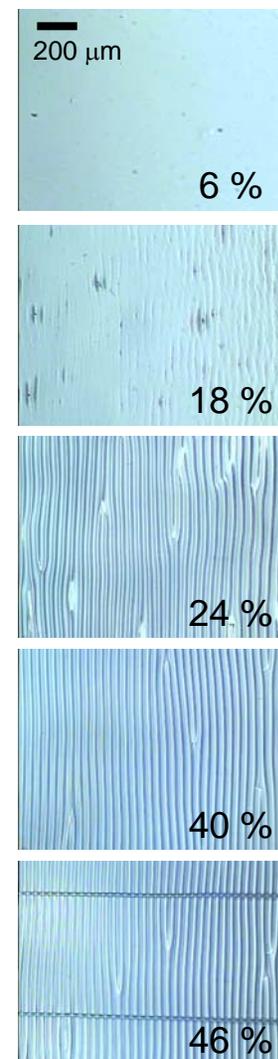
Future Plans  **Critical strain/stress vs Film annealing time**

Critical strain - wettability

o Another way is through wettability



strain increases



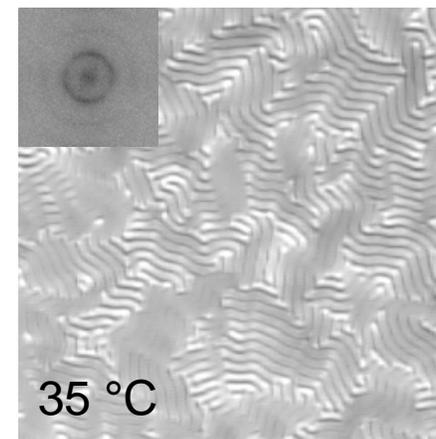
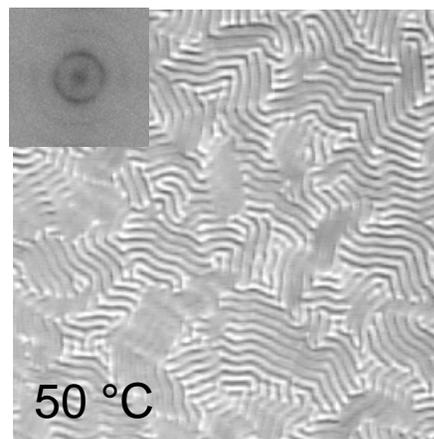
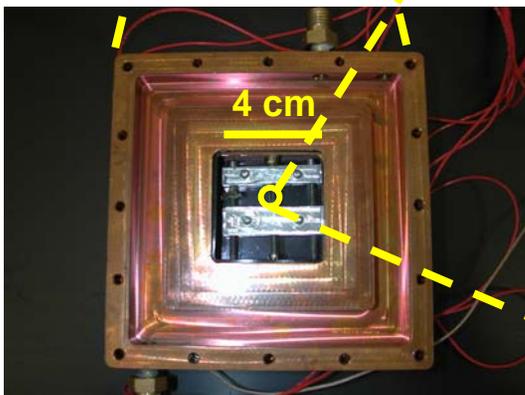
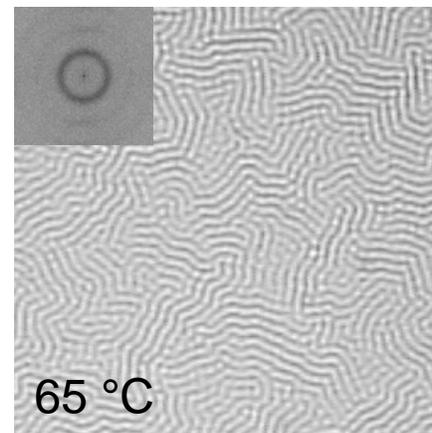
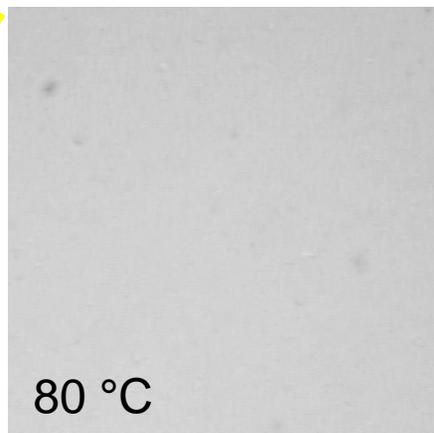
UVO / PDMS

$$\frac{A}{\lambda} \propto \varepsilon^{1/2}$$

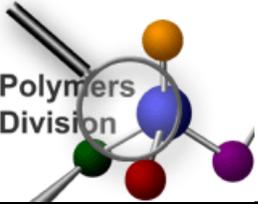
Access to temperature dependent properties

PS Film / PDMS

$$\bar{E}_f(T) = 3\bar{E}_s \left(\frac{\lambda(T)}{2\pi h_f} \right)^3$$



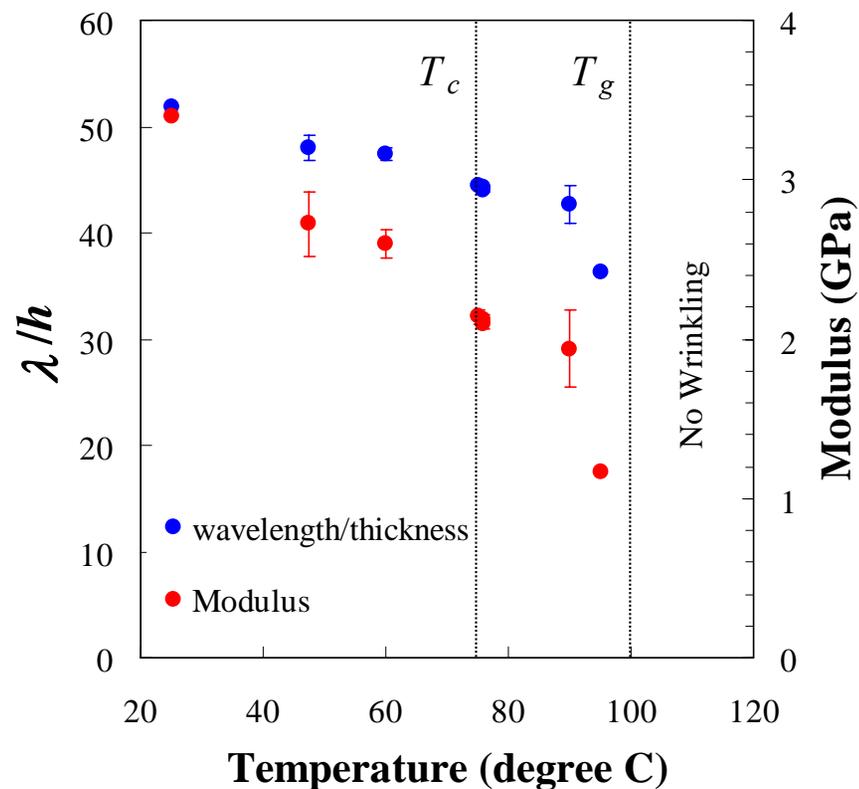
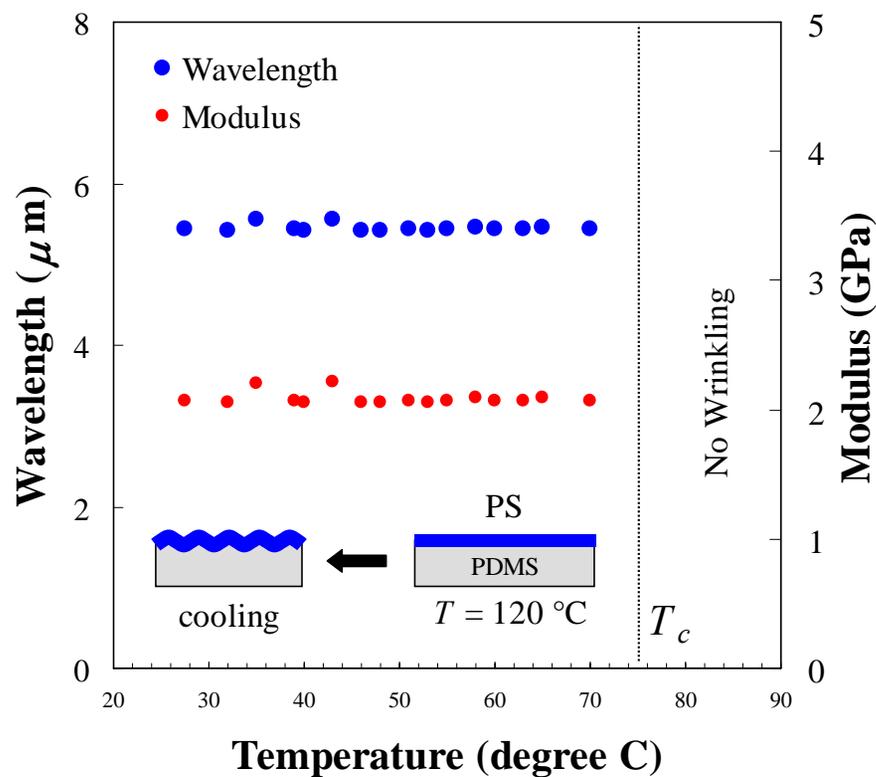
Miniaturized strain stage in a temperature controlled chamber

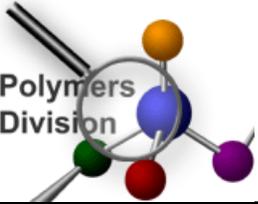


Thermal wrinkling

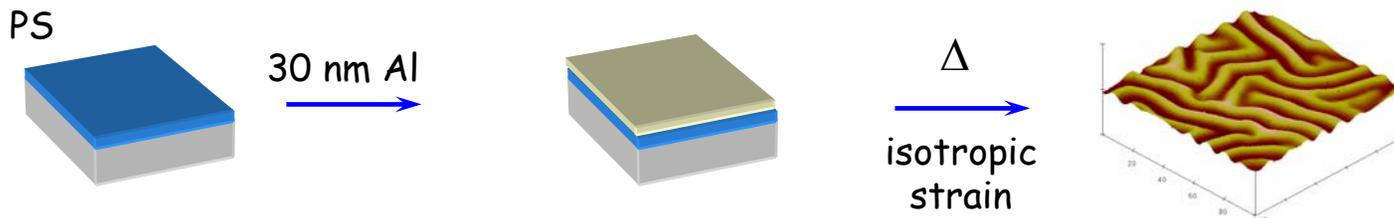
Access to temperature dependent properties

PS Film / PDMS

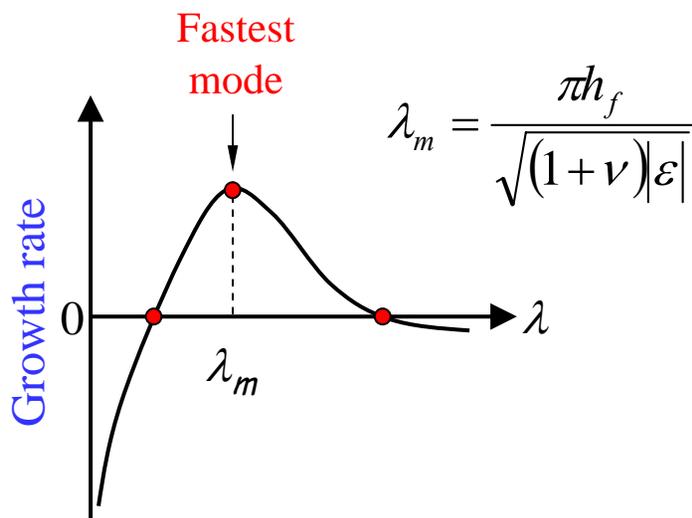




Viscoelastic wrinkling

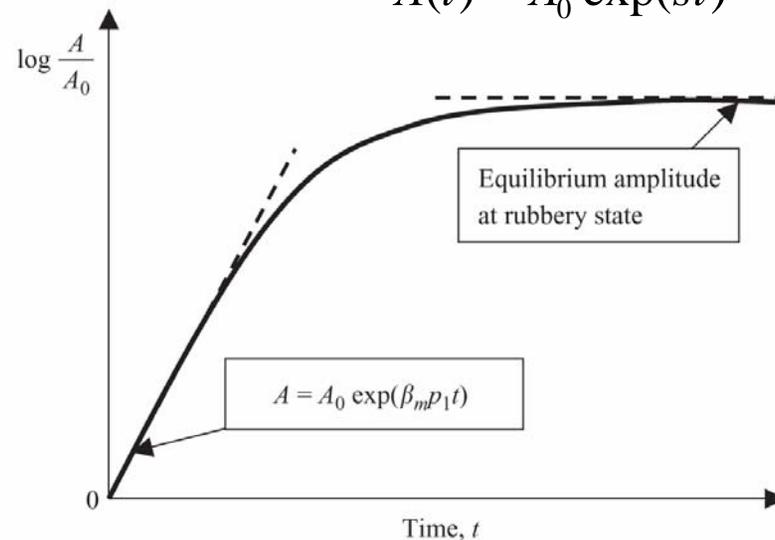


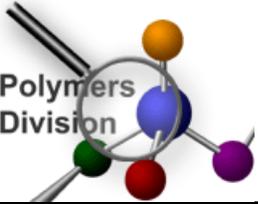
The **wavelength** of the instability is initially selected by the magnitude of the compressive strain and the thickness of the Al layer.



The **amplitude** of the instability grows exponentially with time until it saturates at the rubbery state.

$$A(t) = A_0 \exp(st)$$

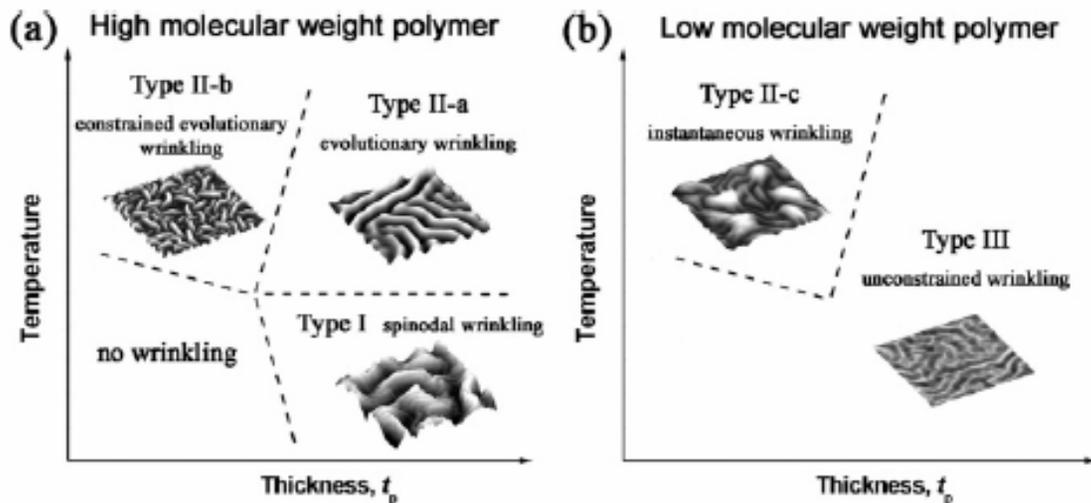
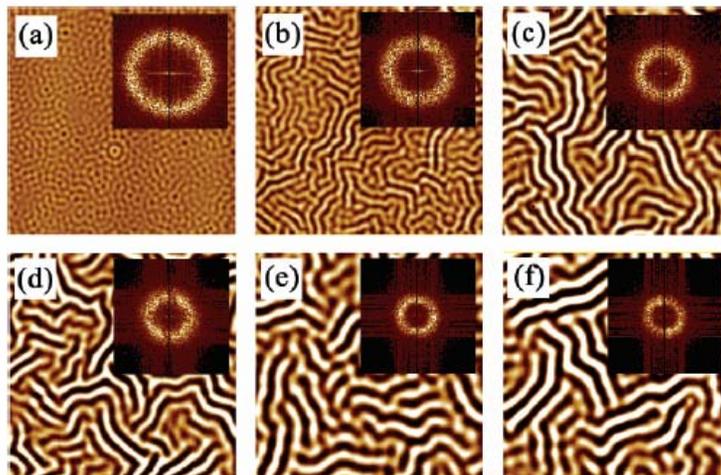


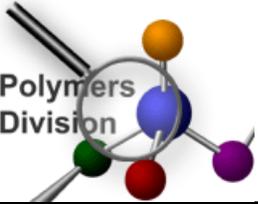


Thermal (viscoelastic) wrinkling

NIST

National Institute of Standards and Technology
Technology Administration, U.S. Department of Commerce



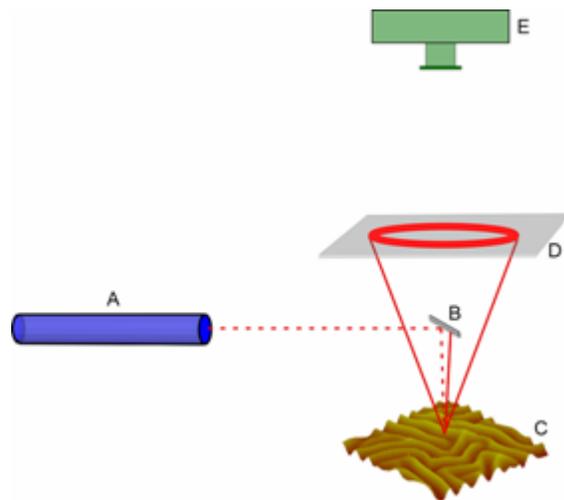


Thermal (viscoelastic) wrinkling

NIST

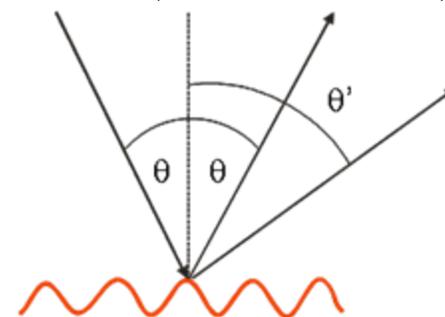
National Institute of Standards and Technology
Technology Administration, U.S. Department of Commerce

Scattering Set-up

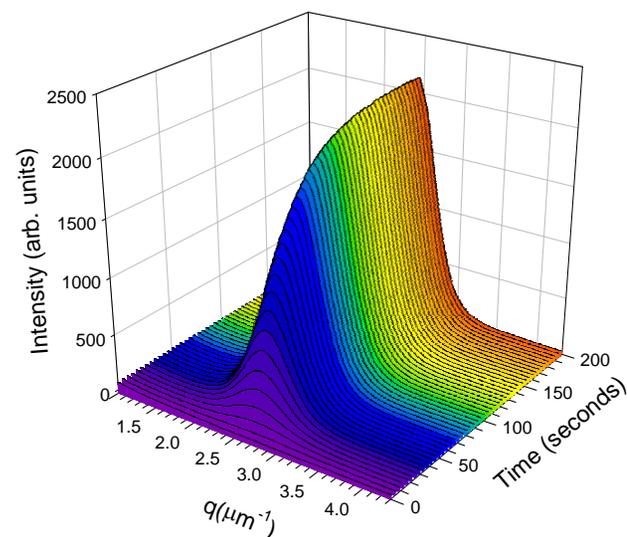
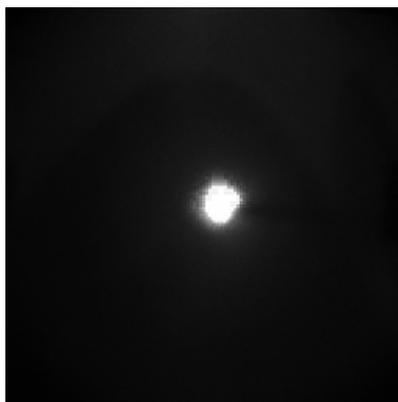


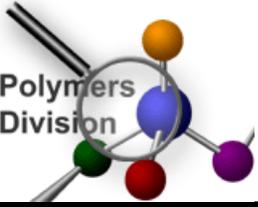
Scattering From Surface Grating

$$n\lambda = d(\sin[\theta] \pm \sin[\theta'])$$

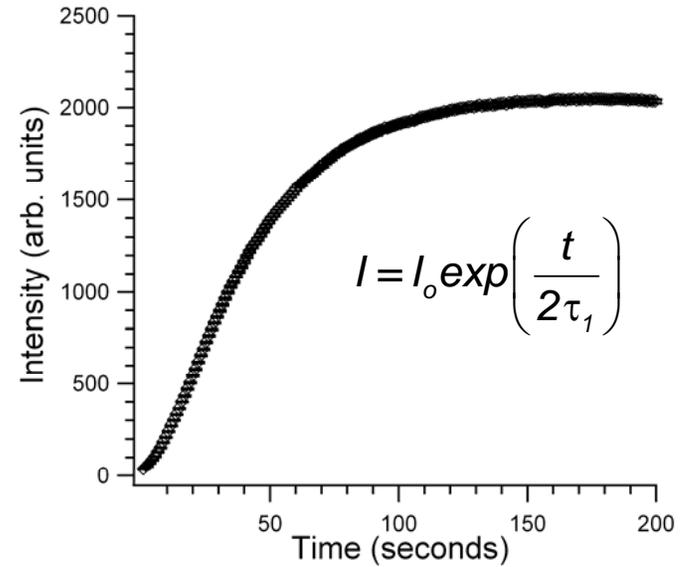
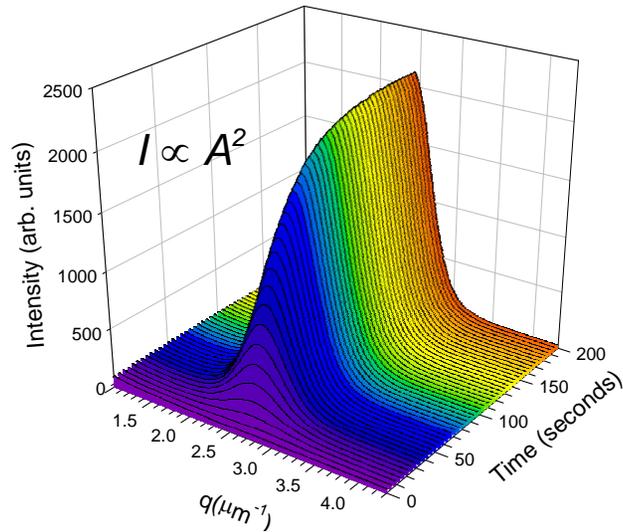


Real-time Scattering

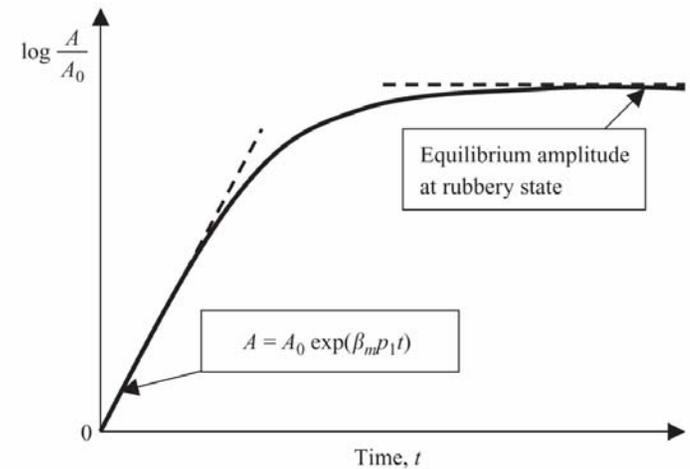




Real-Time Surface Scattering

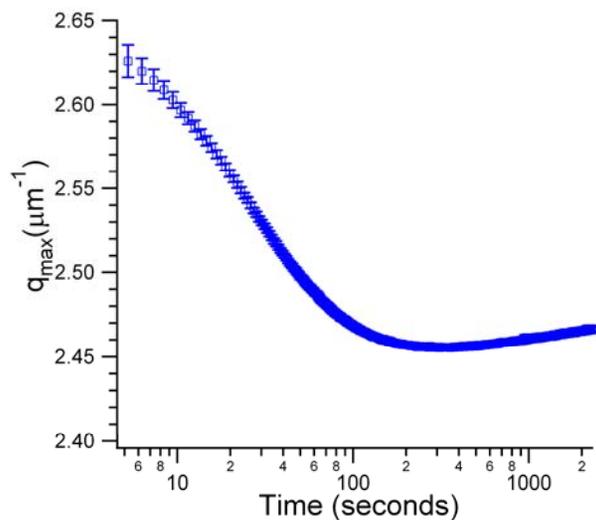
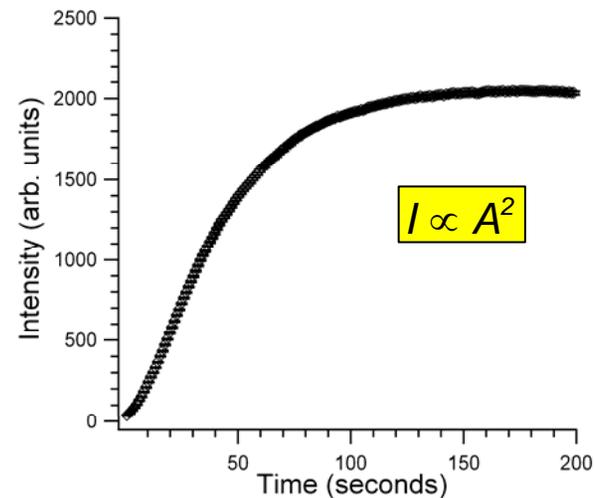
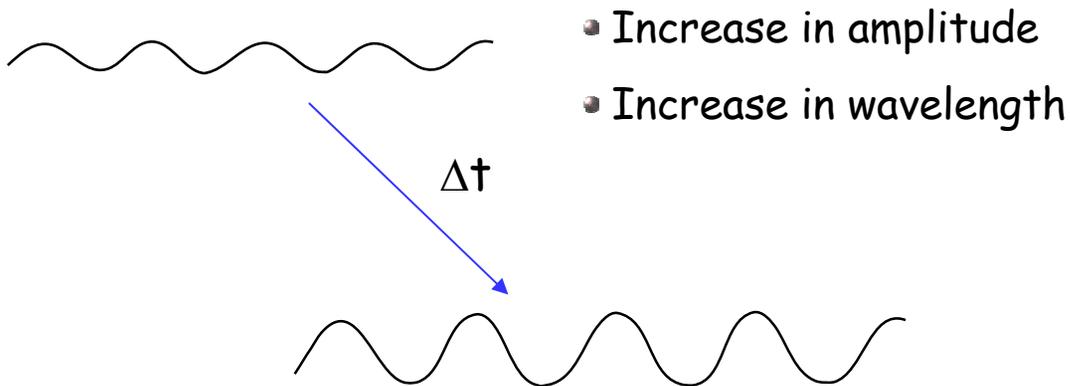


- Scattering data is easily reduced
- Exponential growth of intensity with time
- Excellent agreement with theory

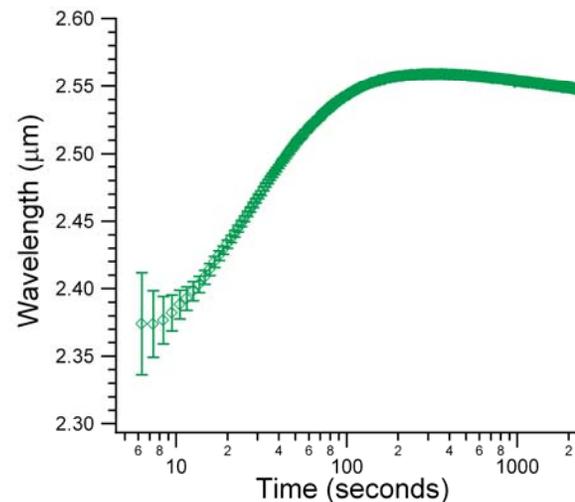
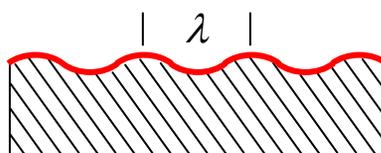


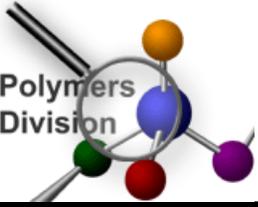


Scattering Data



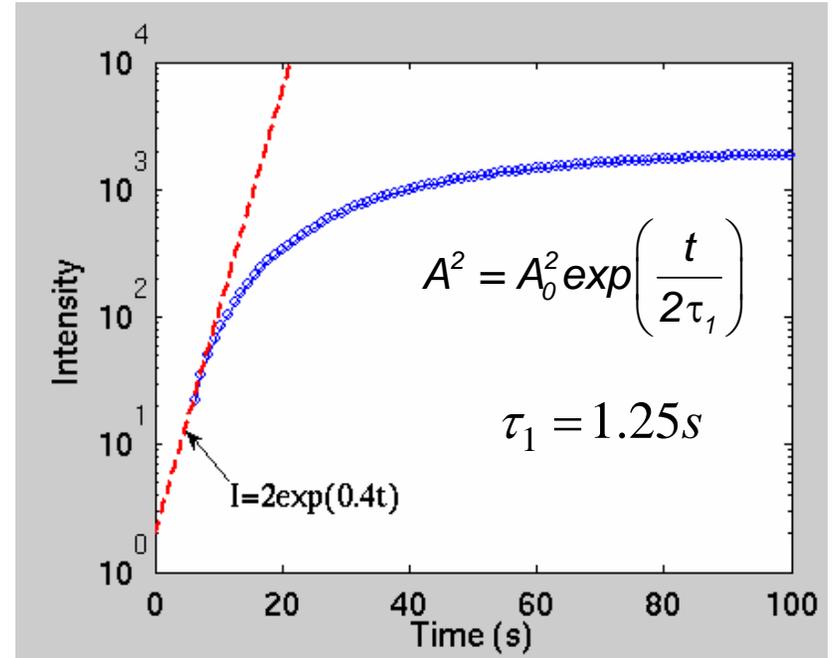
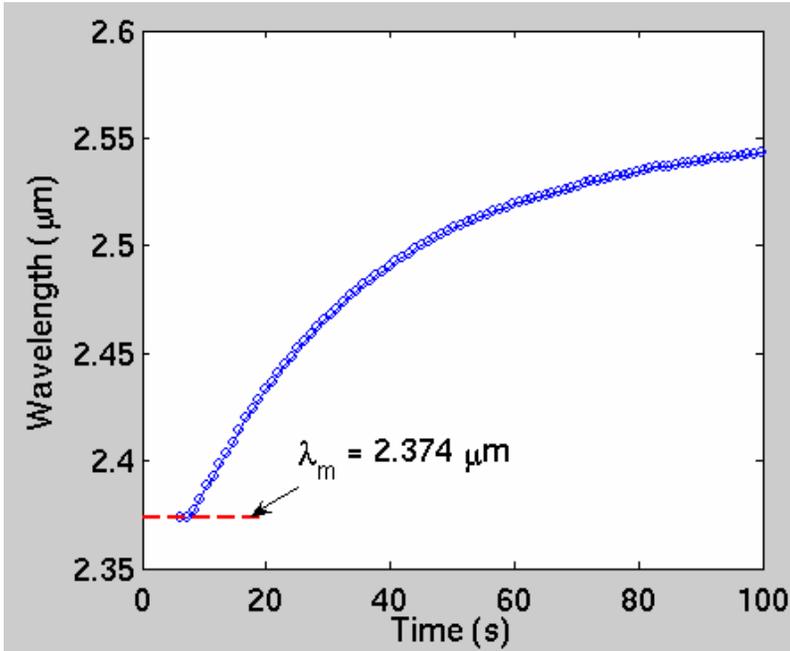
$$\lambda = \frac{2\pi}{q_{\max}}$$





Early Wrinkling and Viscosity

Initial stage (constant wavelength, exponential growth in amplitude):

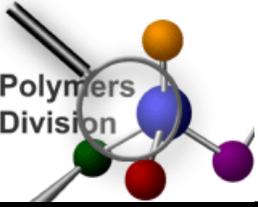


$$\lambda_m = \sqrt{-\frac{4\pi^2 \mu_f h_f^2}{3(1-\nu_f)\sigma_0}}$$

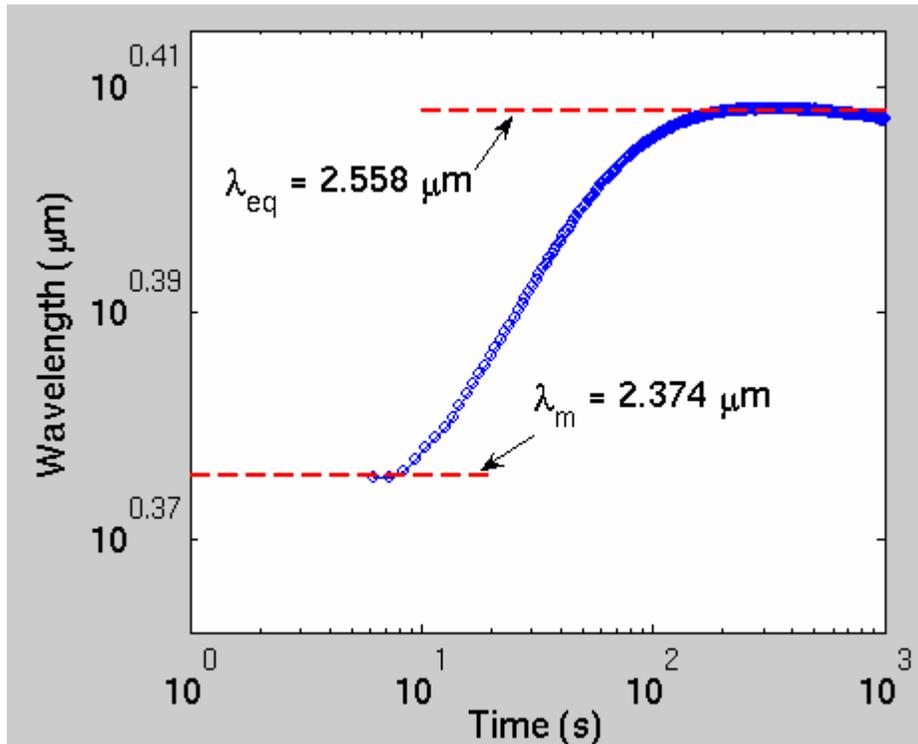
$$\sigma_0 = 58.4 \text{ MPa}$$

$$\tau_1 = \frac{(1-\nu)h_f \mu_f \eta}{3(1-2\nu)(1-\nu_f)H\sigma_0^2}$$

$$\eta = 6.28 \times 10^5 \text{ Pa} \cdot \text{s}$$



Wrinkling



- AFM results yield ~ 6.4 nm

Equilibrium wavelength:

$$\lambda_{eq} = 2\pi h_f \left[\frac{(1-2\nu)\mu_f H}{12(1-\nu)(1-\nu_f)\mu_R h_f} \right]^{1/4}$$

$$\mu_R = 0.0931 \text{ MPa}$$

Critical stress:

$$\sigma_c = -\sqrt{\frac{4(1-\nu)}{3(1-2\nu)(1-\nu_f)} \frac{h_f}{H} \mu_f \mu_R}$$

$$= 50.3 \text{ MPa}$$

Equilibrium amplitude:

$$A_{eq} = h_f \sqrt{\frac{2}{3} \left(\frac{\sigma_0}{\sigma_c} - 1 \right)}$$

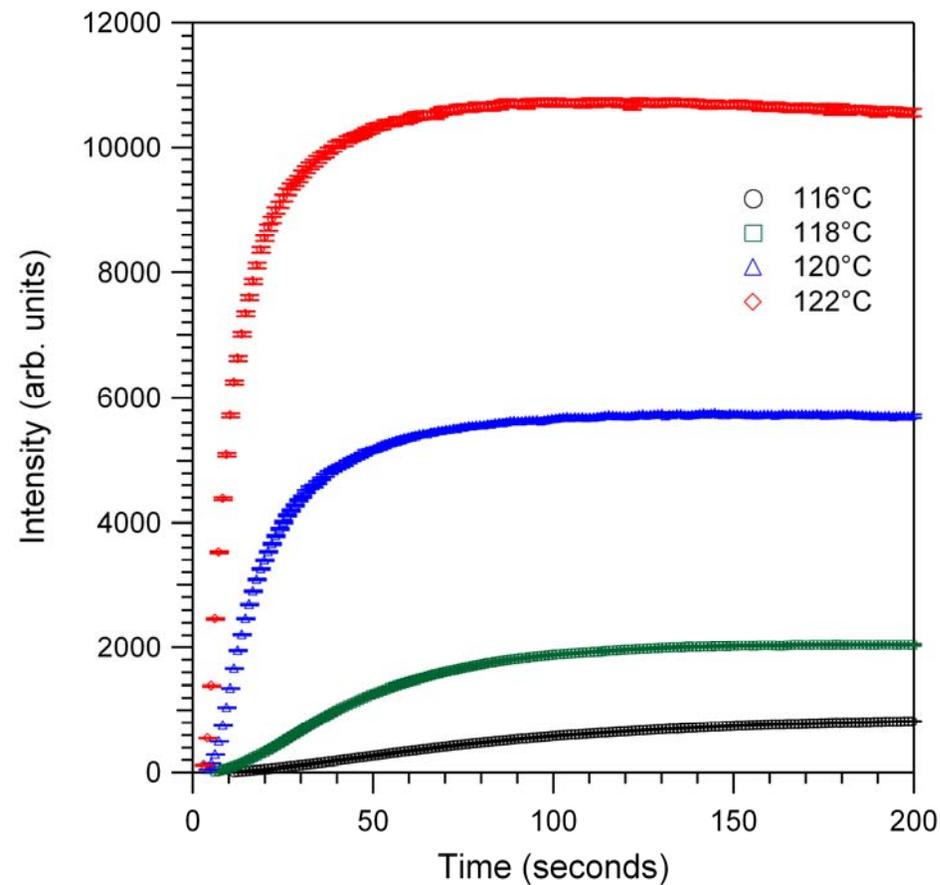
$$= 8.19 \text{ nm}$$



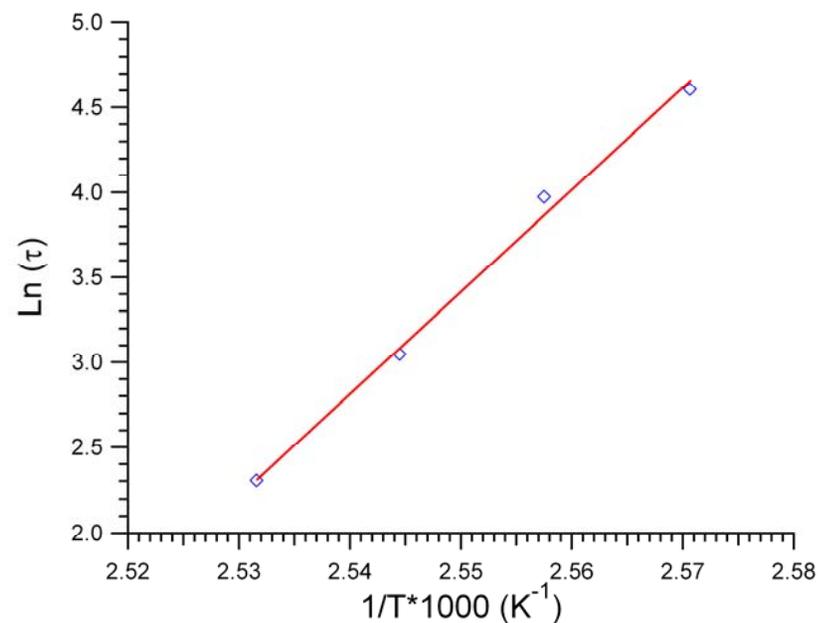
Temperature Dependence

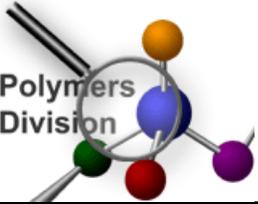
NIST

National Institute of Standards and Technology
Technology Administration, U.S. Department of Commerce



- Rate increases with T
- Equilibrium intensity increases with T





Patterning

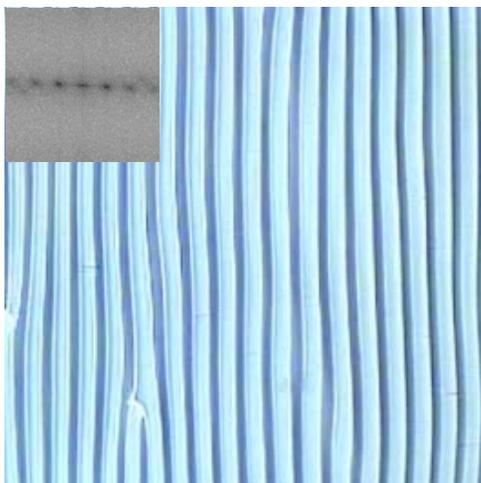
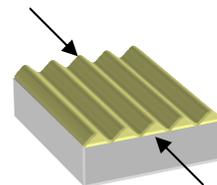
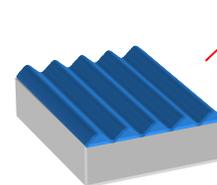
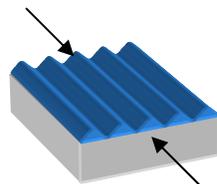
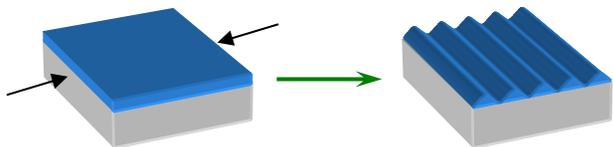
Mechanical strain

+

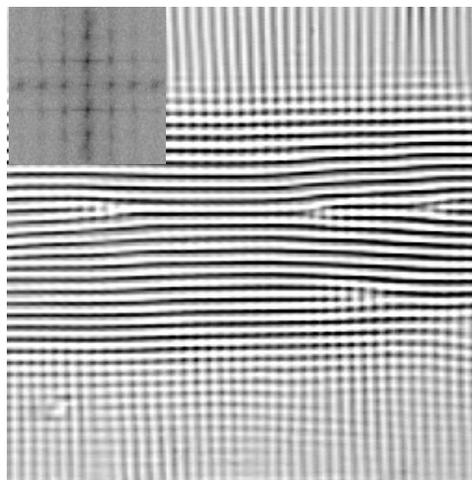
Thermal strain

or

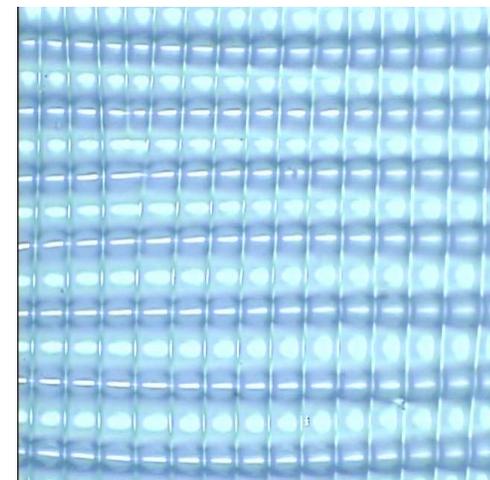
Replicate + Mechanical



stripes



checkerboard



λ_1 selected by h_f, E_f
 λ_2 selected by $h_f, E_f(T_c)$

λ_1 selected by h_{f1}, E_{f1}
 λ_2 selected by h_{f2}, E_{f2}



Acknowledgements

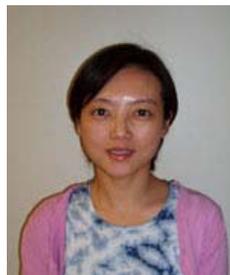
NIST

National Institute of Standards and Technology
Technology Administration, U.S. Department of Commerce

Project Team:



Jun Young Chung



Heqing Huang

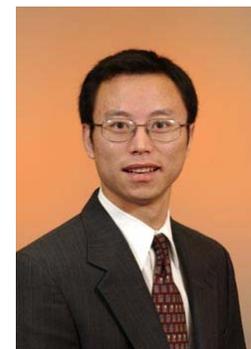


Adam J. Nolte



Kirt A. Page

Collaborators:



Rui Huang
UT Austin



This work was carried out at the
NIST Combinatorial Methods Center
www.nist.gov/combi